

Integrating Atom Probe Tomography and Transmission Electron Microscopy into a Single Instrument

Eric Van Cappellen; Joachim Mayer; Rafal E. Dunin-Borkowski;
Joseph Bunton; Frank de Jong and Hugo van Leeuwen.

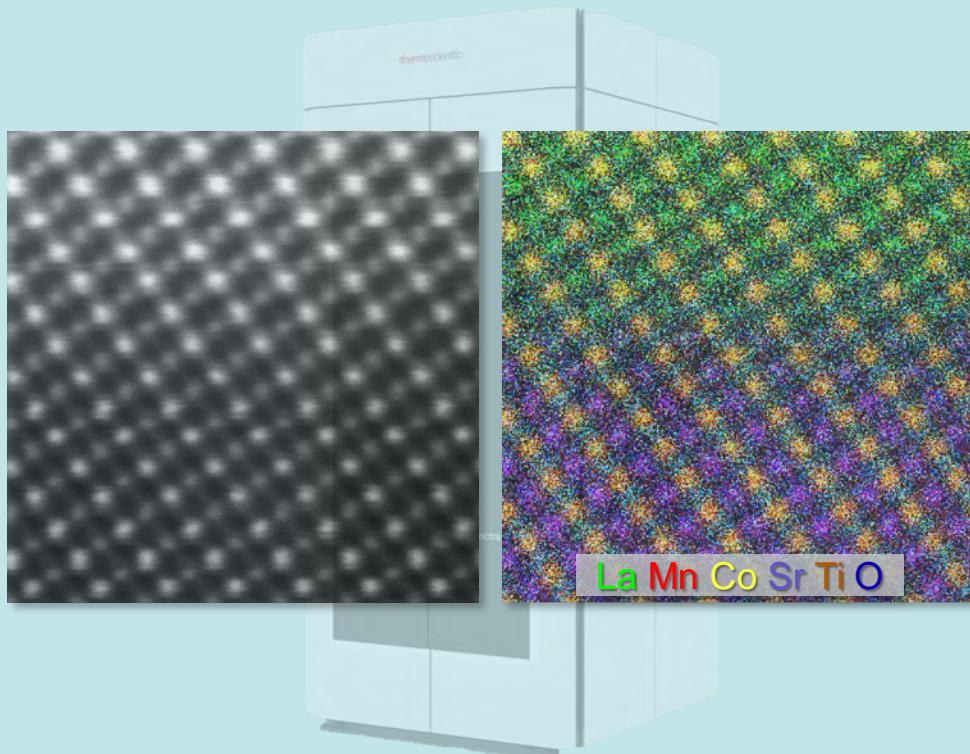
FCMN2024; Monterey April 15th–18th 2024



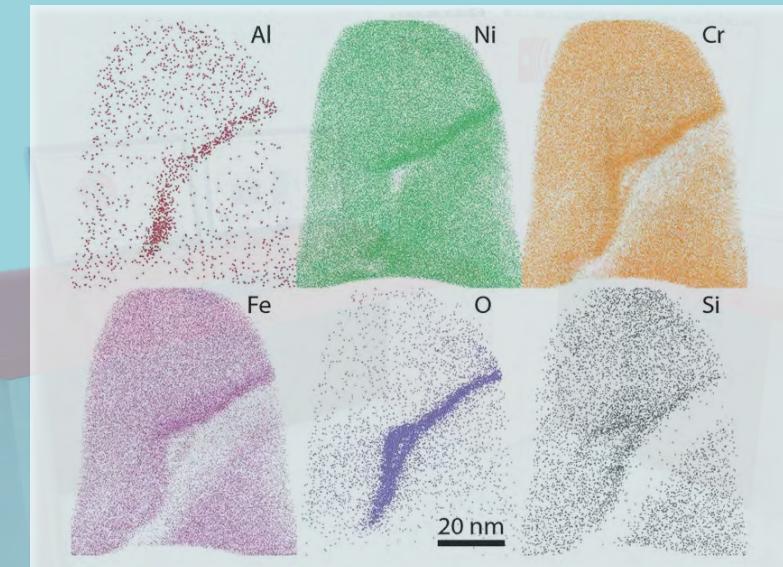
■ The world leader in serving science

Combining two powerful materials characterization techniques

(Scanning) Transmission Electron Microscopy



Atom Probe Tomography



Atomic-Scale Analytical Tomography (ASAT)

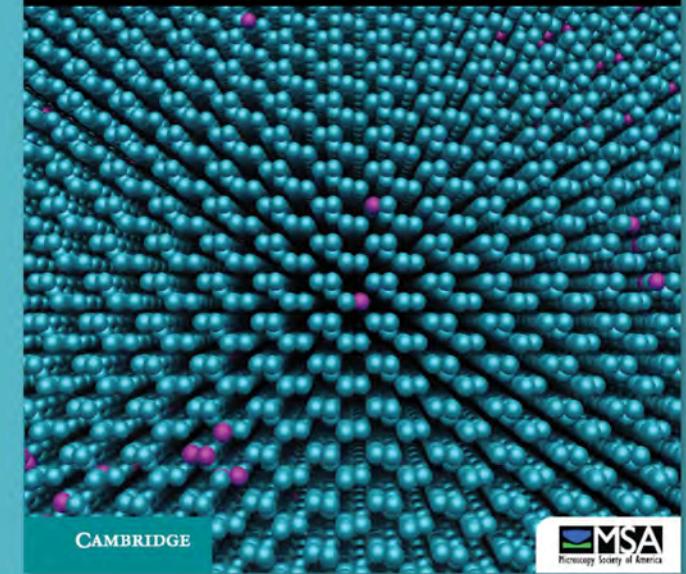
- Integrating an atom probe microscope into a transmission electron microscope

ADVANCES IN MICROSCOPY AND MICROANALYSIS

Atomic-Scale Analytical Tomography

Concepts and Implications

Thomas F. Kelly, Brian P. Gorman
and Simon P. Ringer

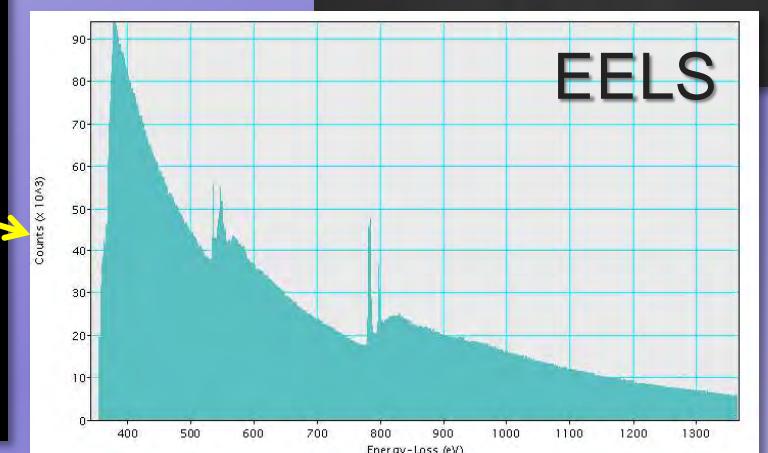
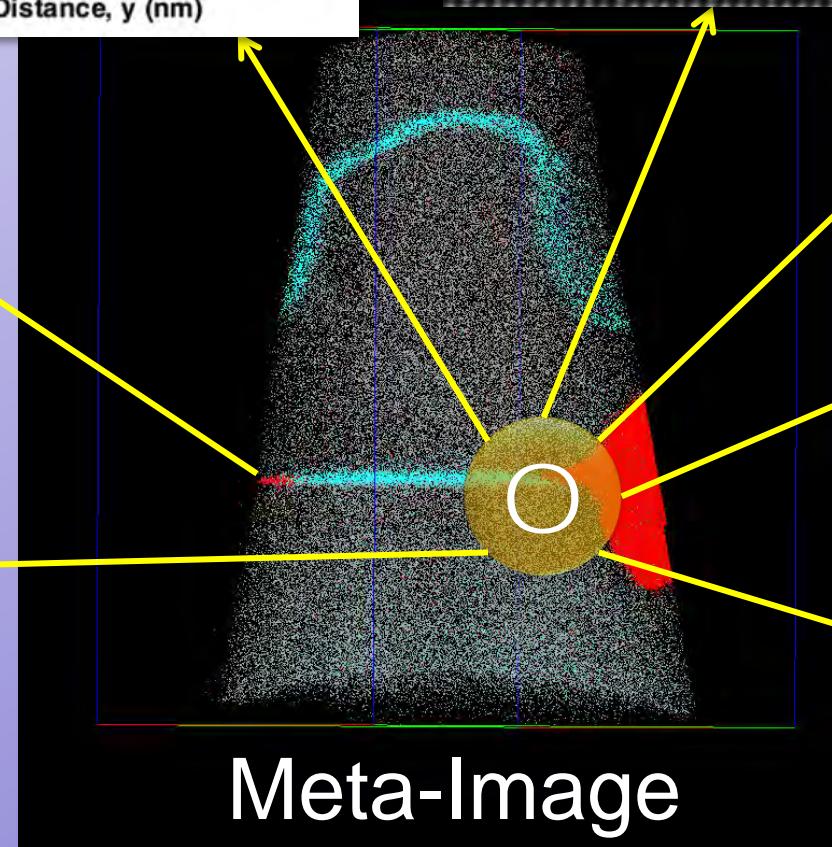
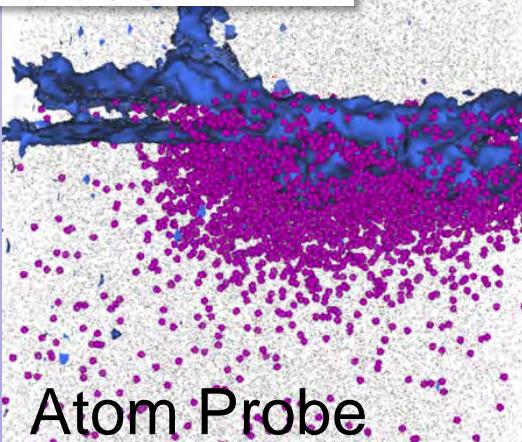
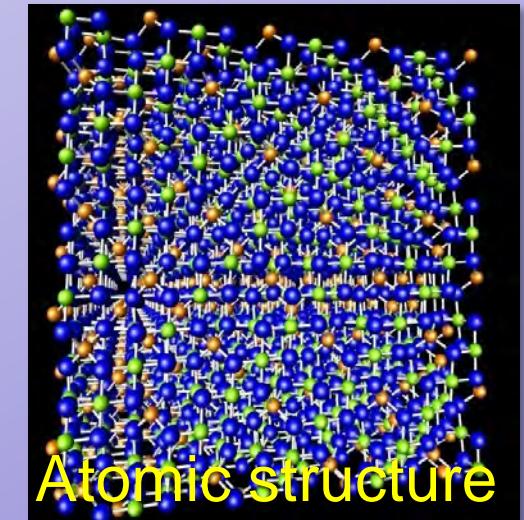
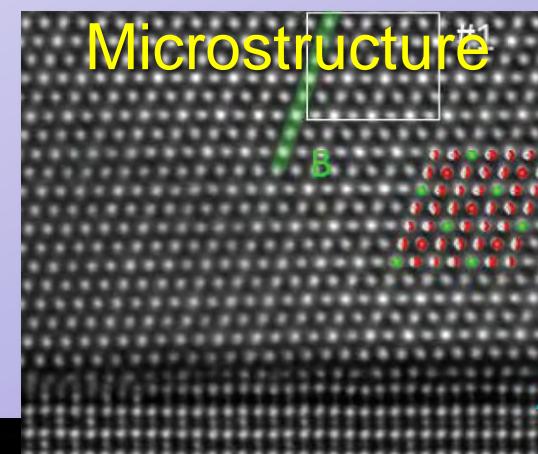
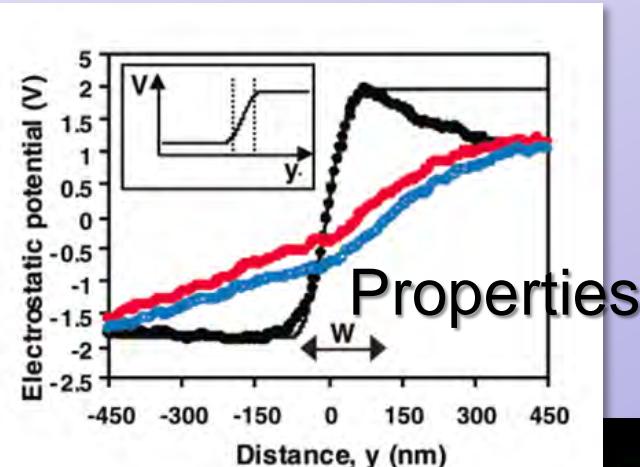
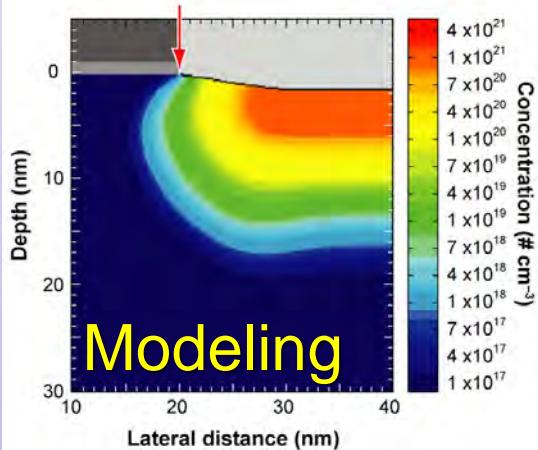


"The largest effort towards ASAT is a recently funded program at the Ernst Ruska Center in Germany called Project Tomo. This project will integrate an atom probe into the objective lens of an aberration-corrected TEM"

Motivation: ASAT

Courtesy: Tom Kelly

- Wishlist



1

Introduction & design challenges

2

The Octagon

3

Ultra High Vacuum

4

Vibration-free cryo cooling

5

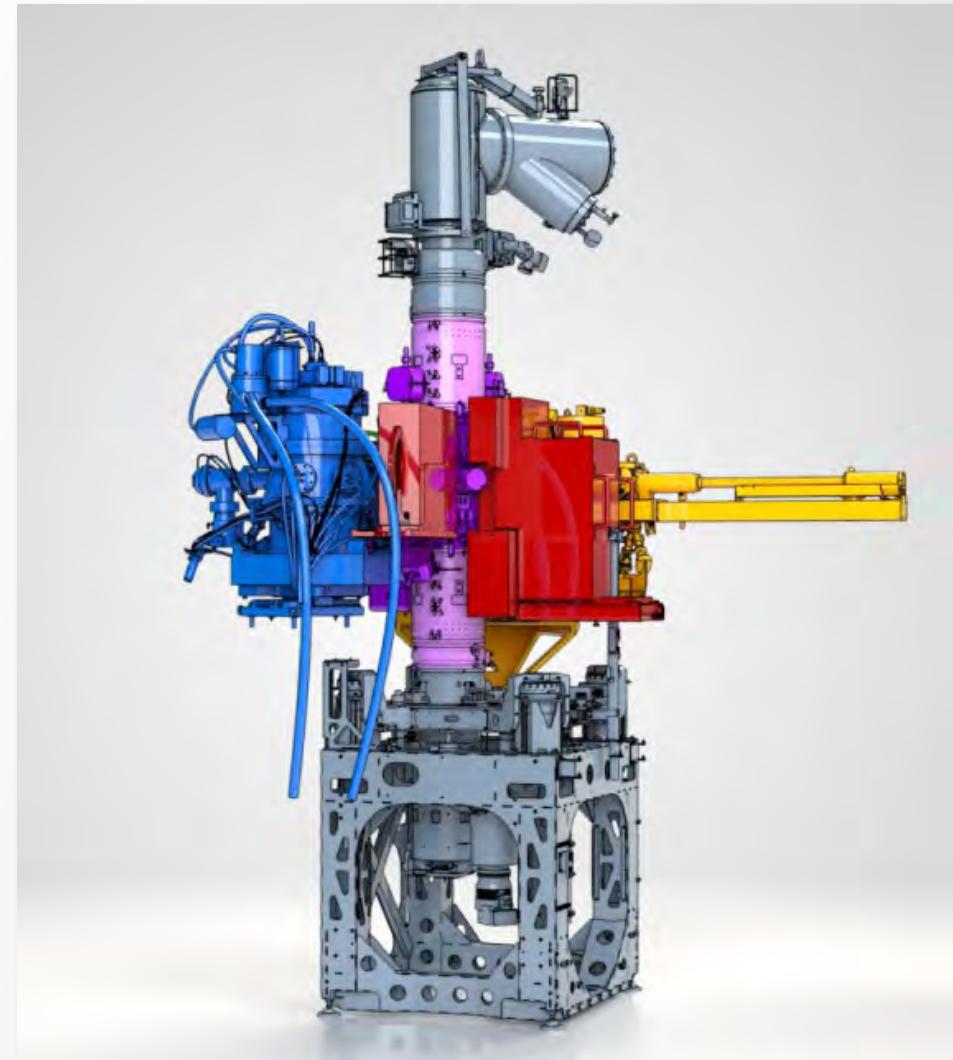
Workflows

6

First experimental results

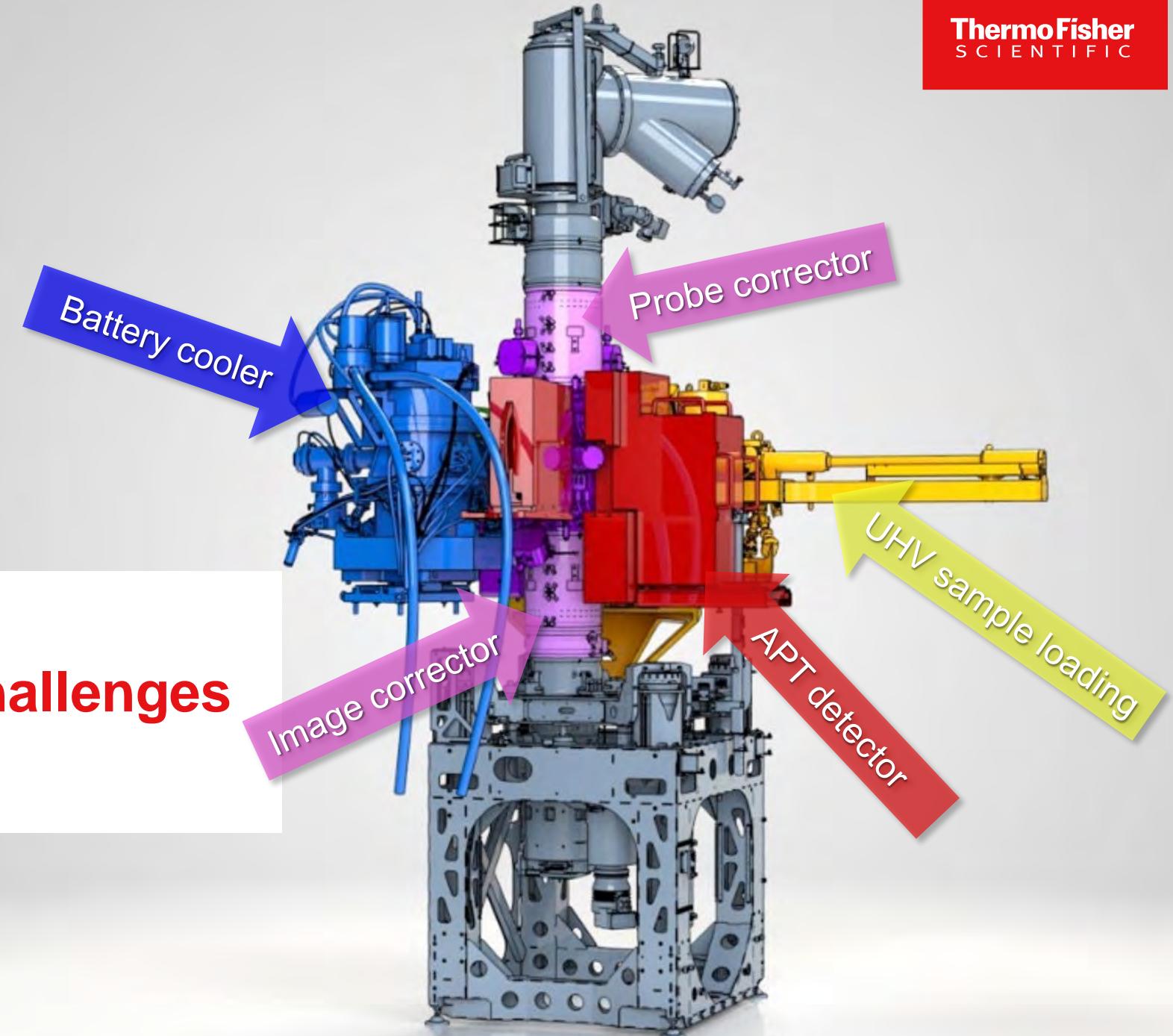
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Closing remarks



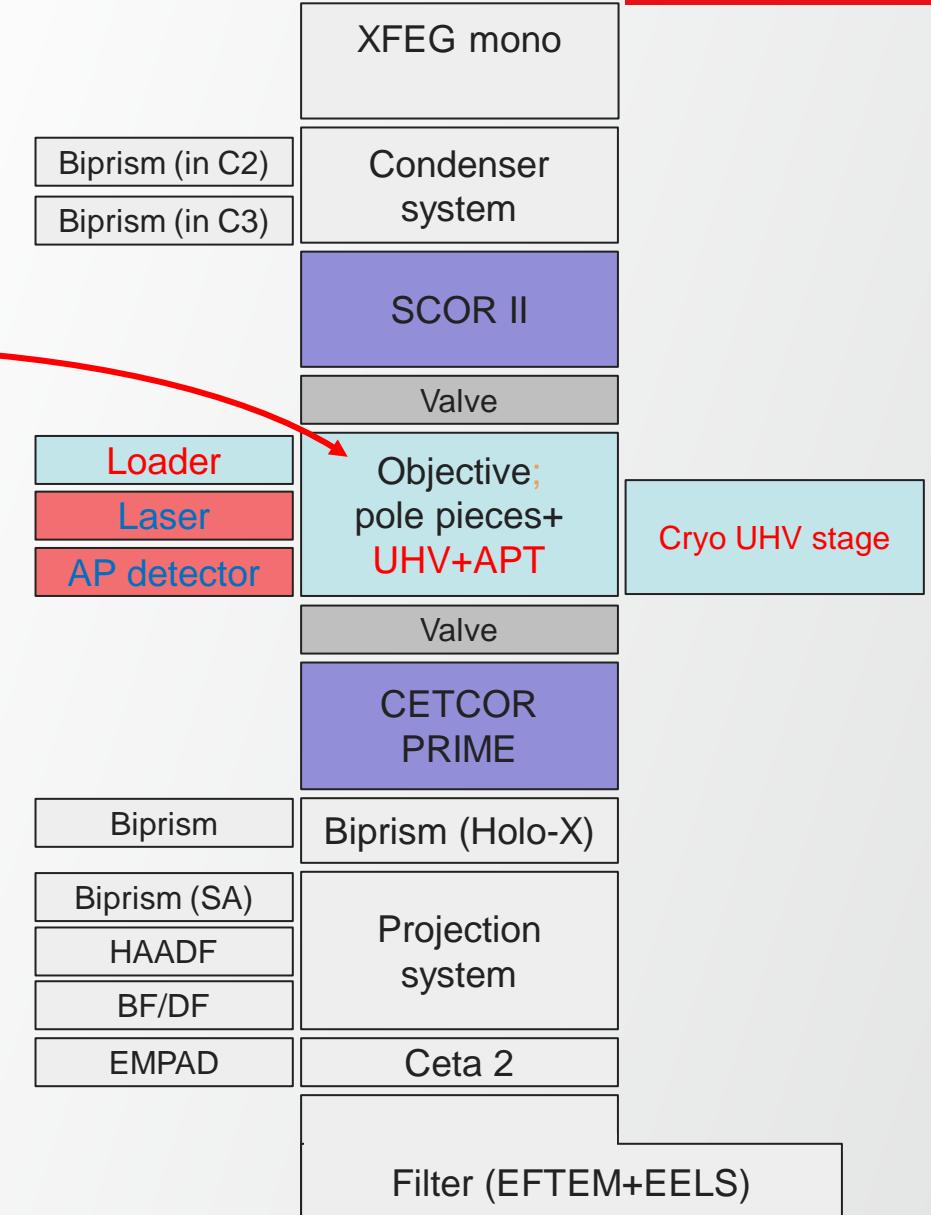
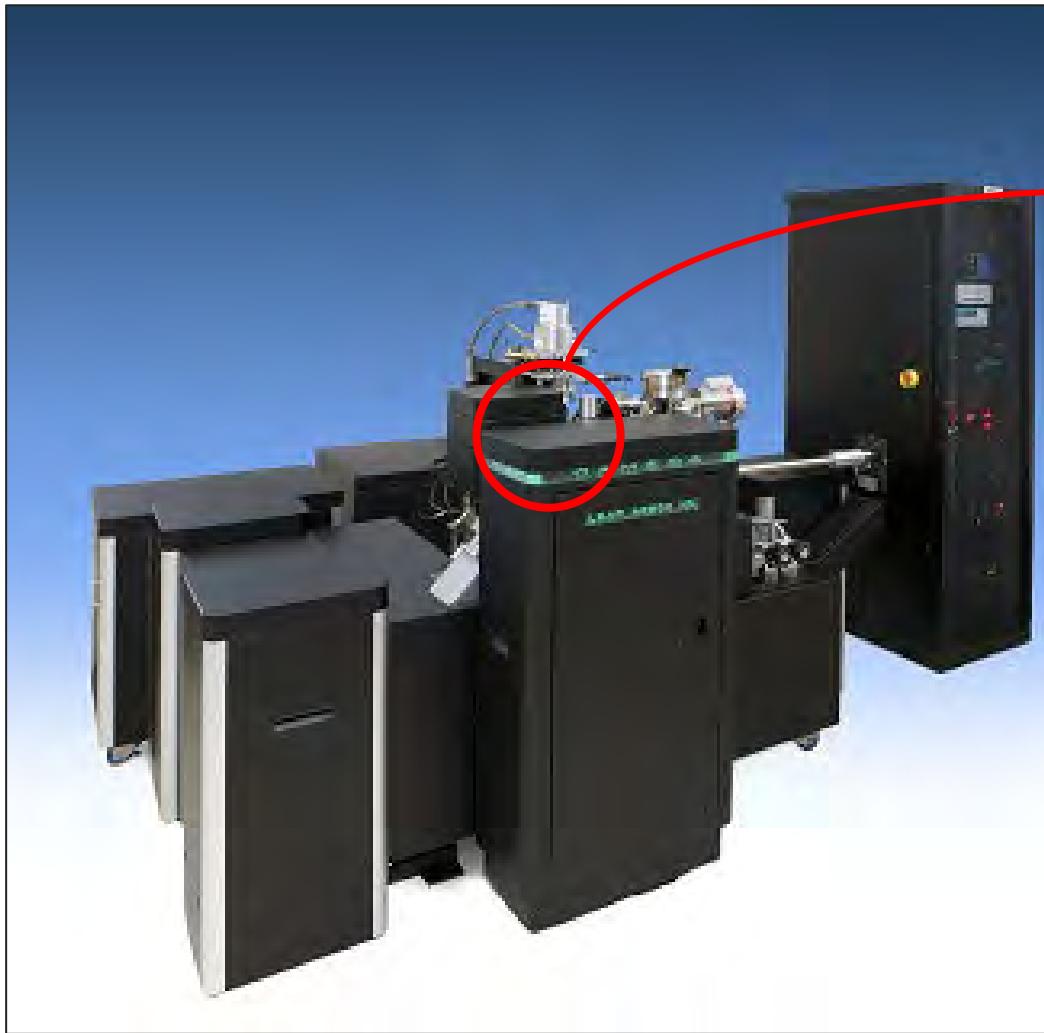
Introduction & design challenges

Integrating an APT into HR-(S)TEM

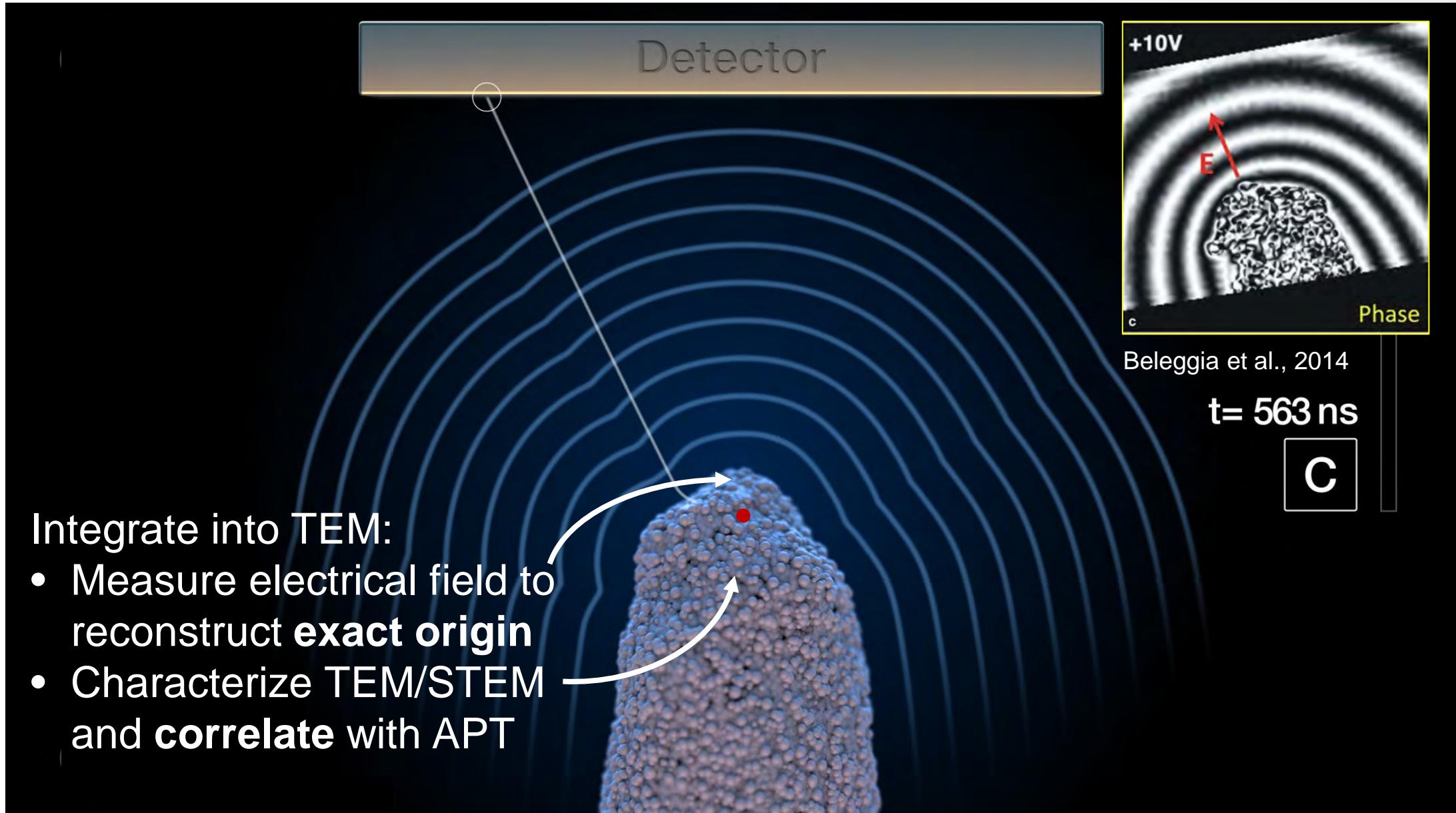


Introduction: Concept

Integrating an Atom Probe Microscope into a high-end (S)TEM

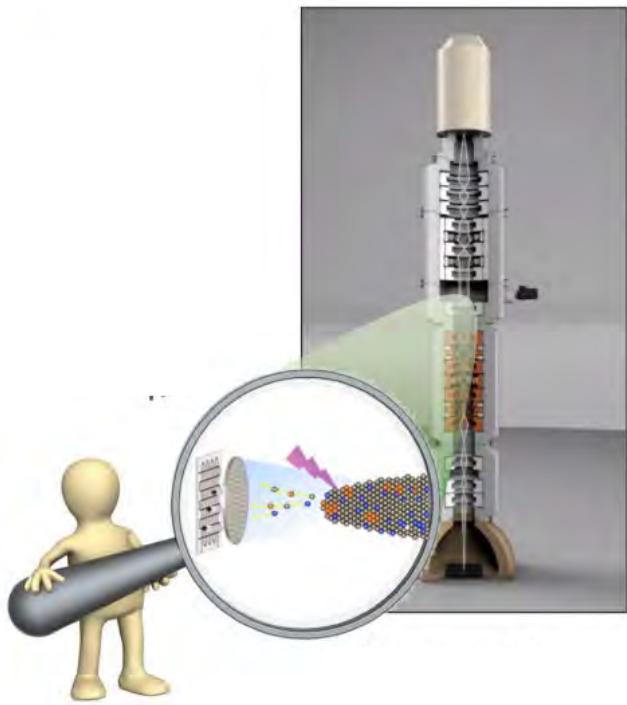


Introduction: APT – Evaporation principle

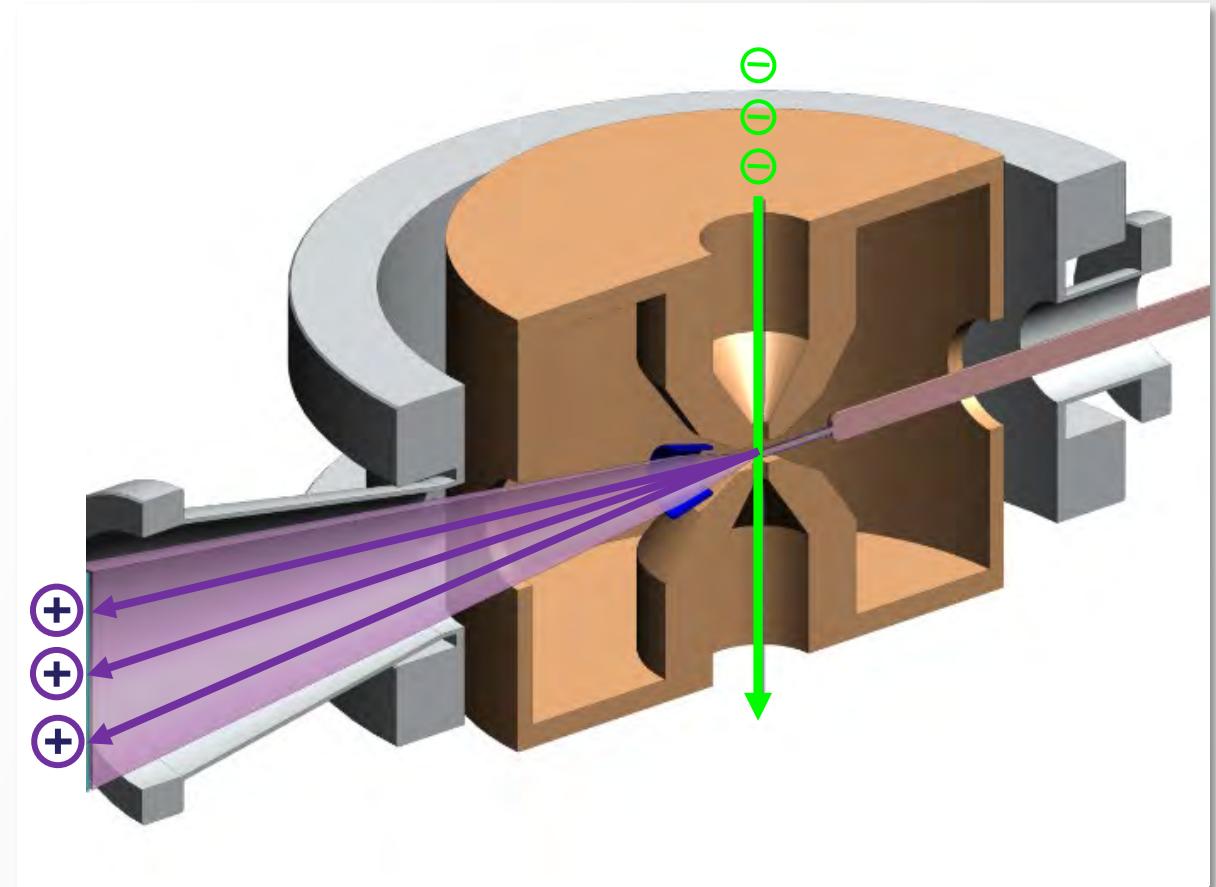


Design challenges: concept

Tomo instrument design



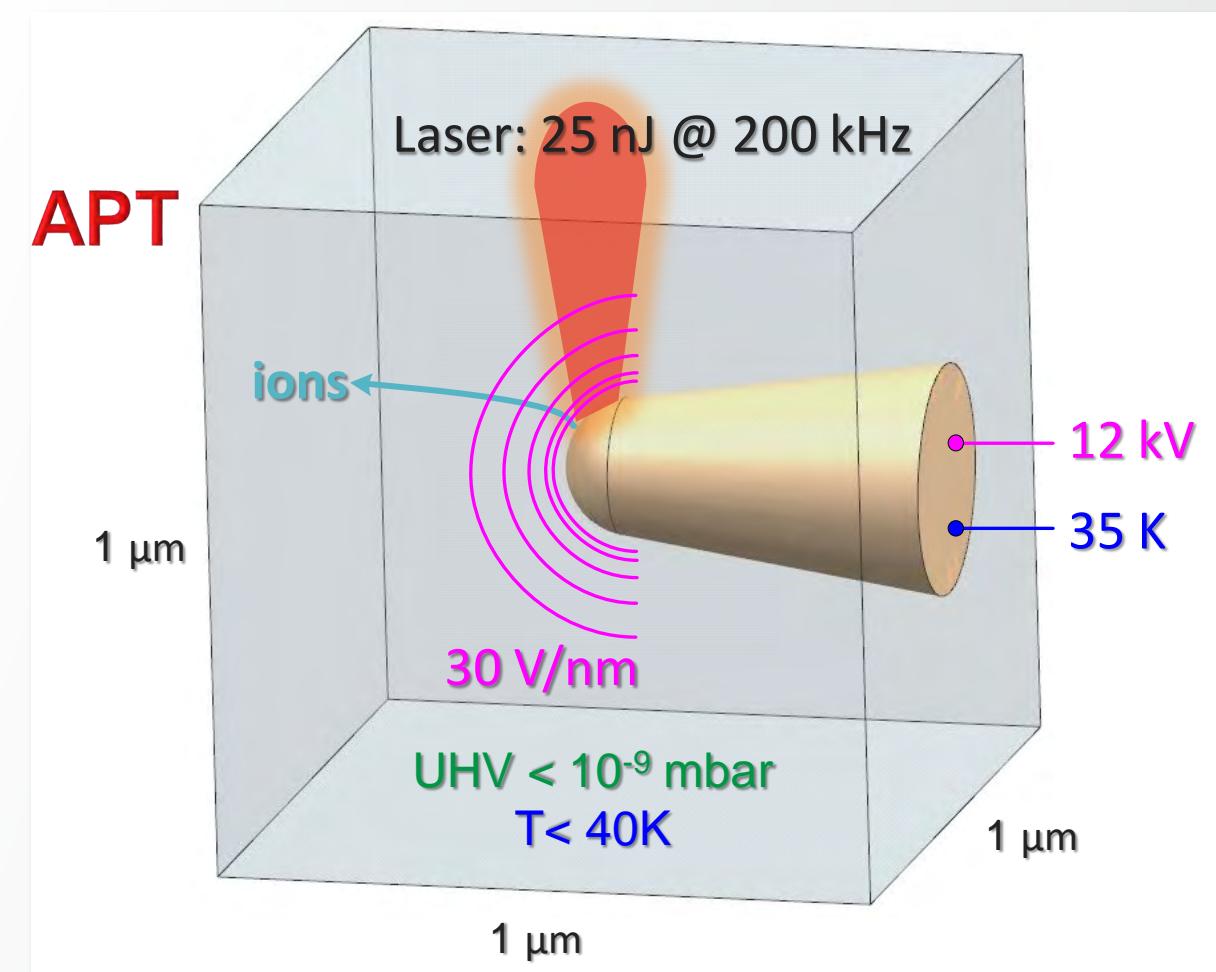
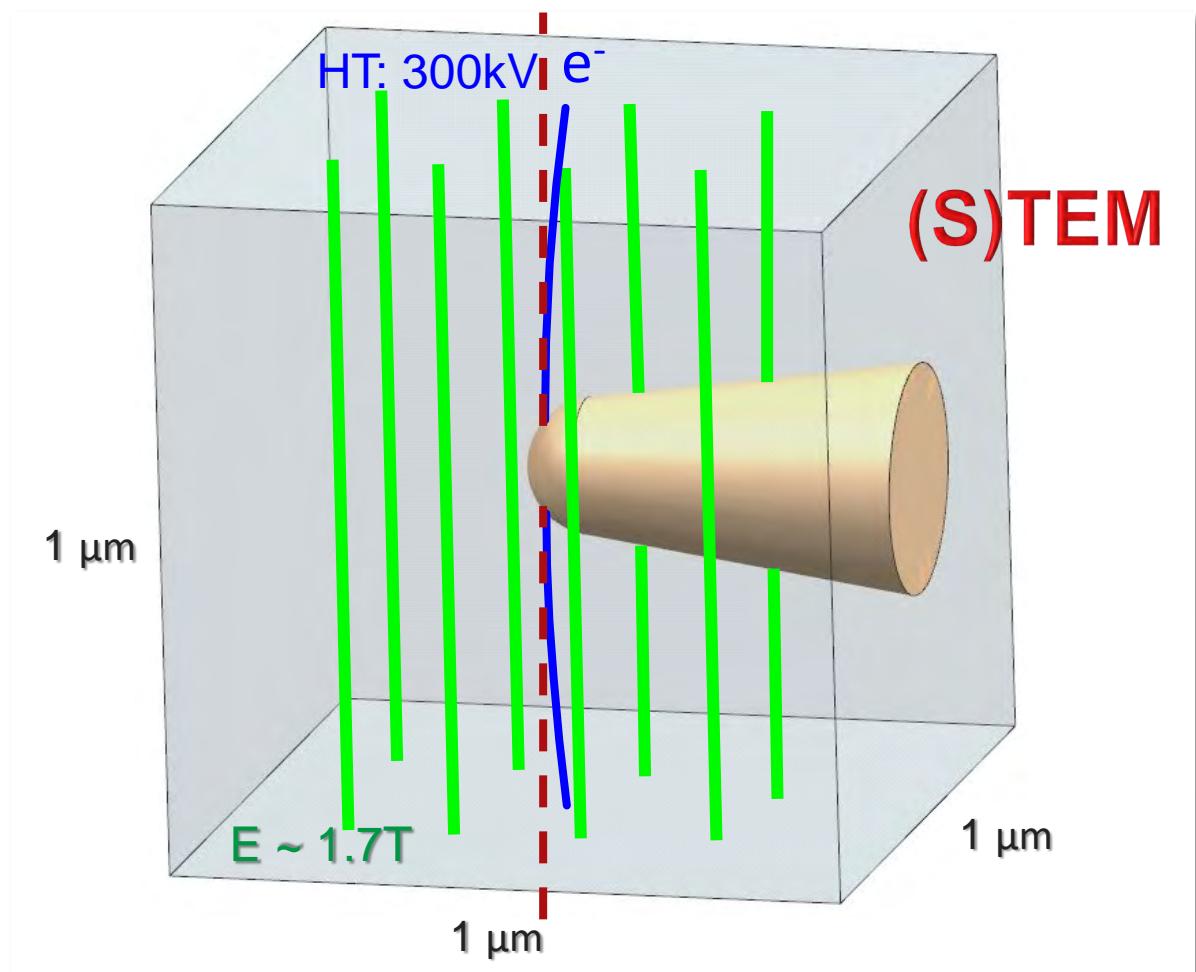
- Consecutive operation: fast switching between:
 - APT mode: **B-field free**
 - (S)TEM mode: **E-field free**



Design challenges: divergent experimental conditions

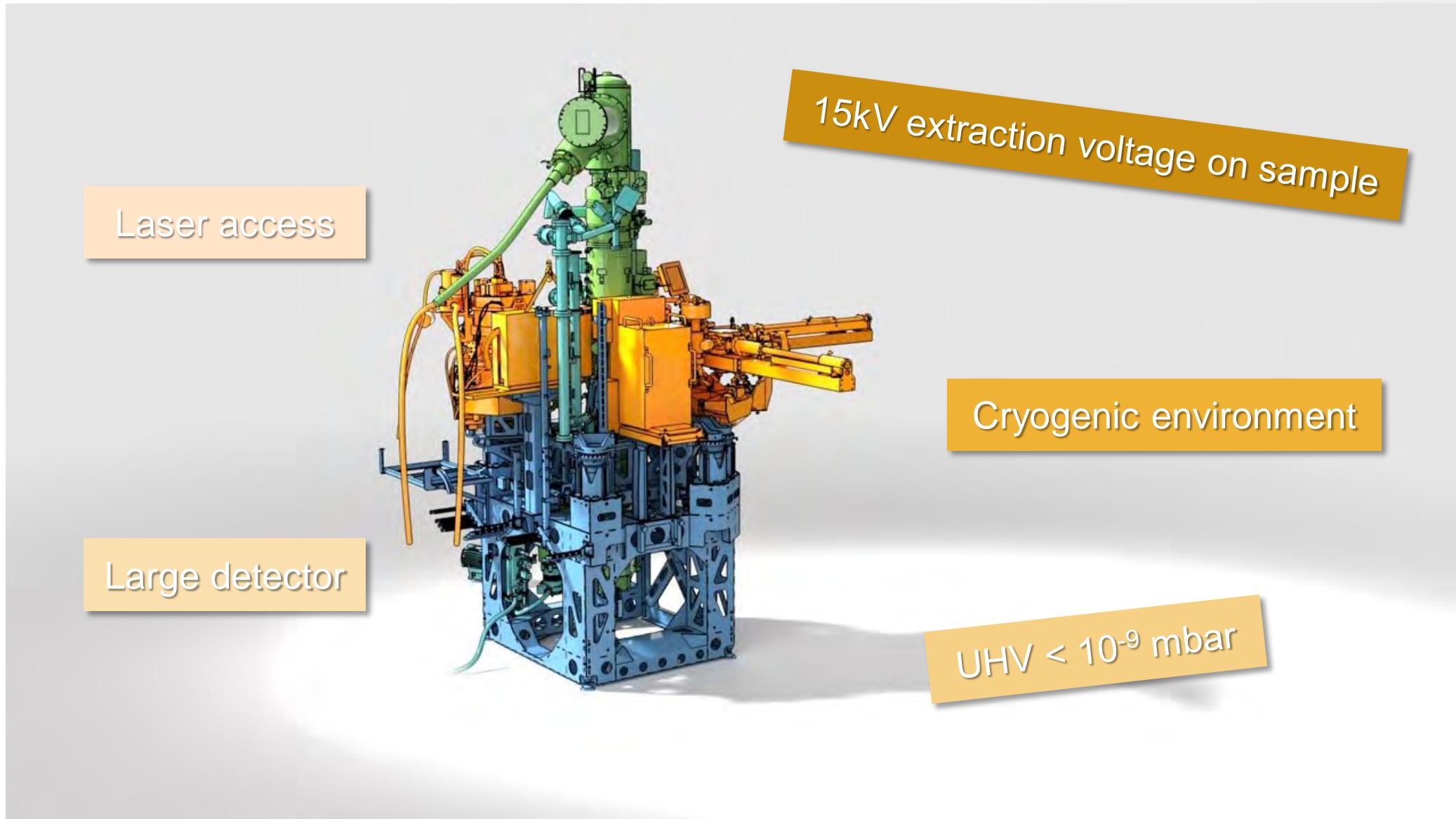
Principal instrument requirements in (S)TEM and APT mode

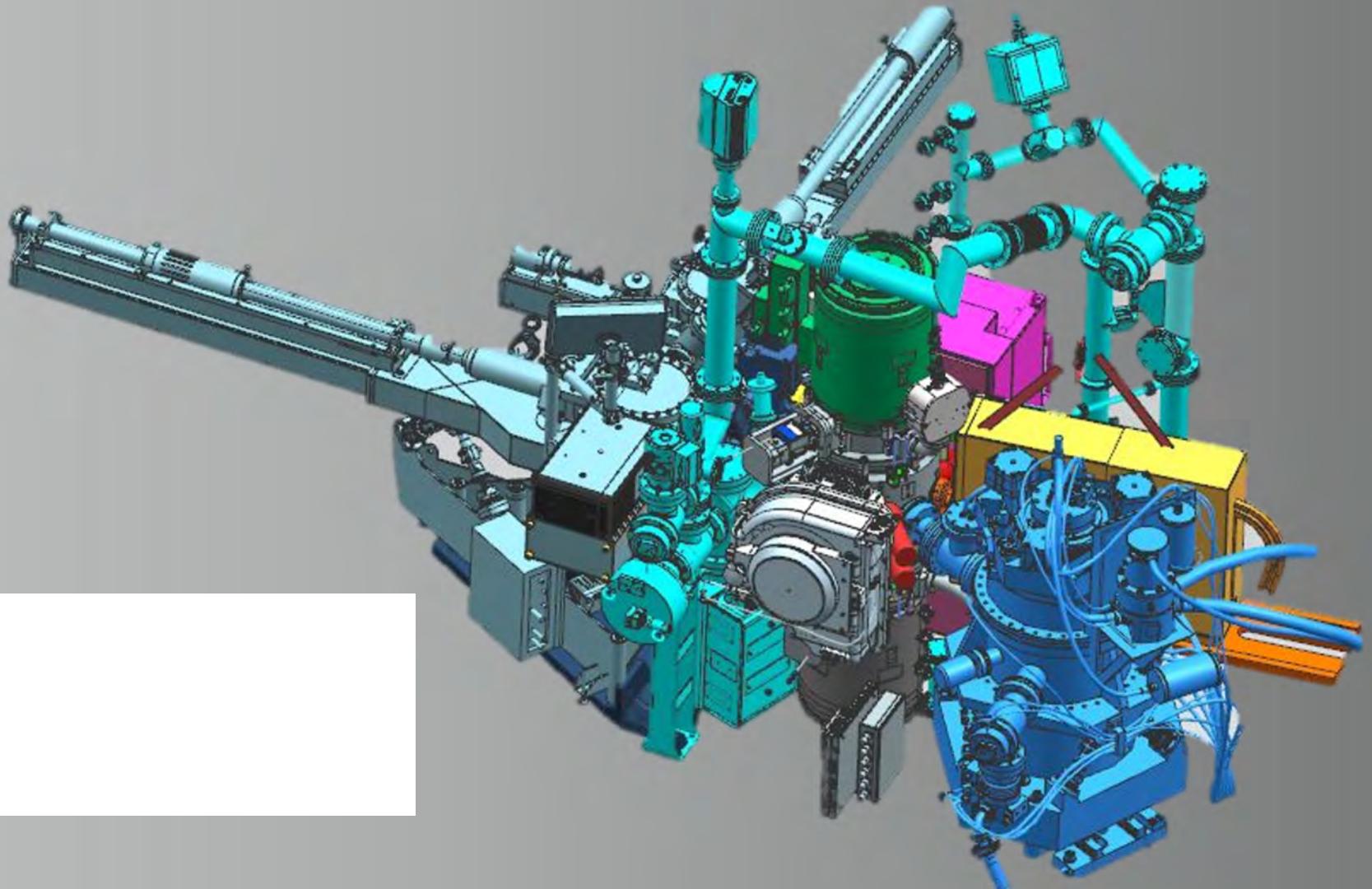
- Very thin sample
- Sample stability: $< 10\text{pm}$ (0.1 – 5000 Hz)
- Needle sample
- Minimize surface diffusion and ion loss.



Design challenges: APT experimental conditions

Extreme requirements:



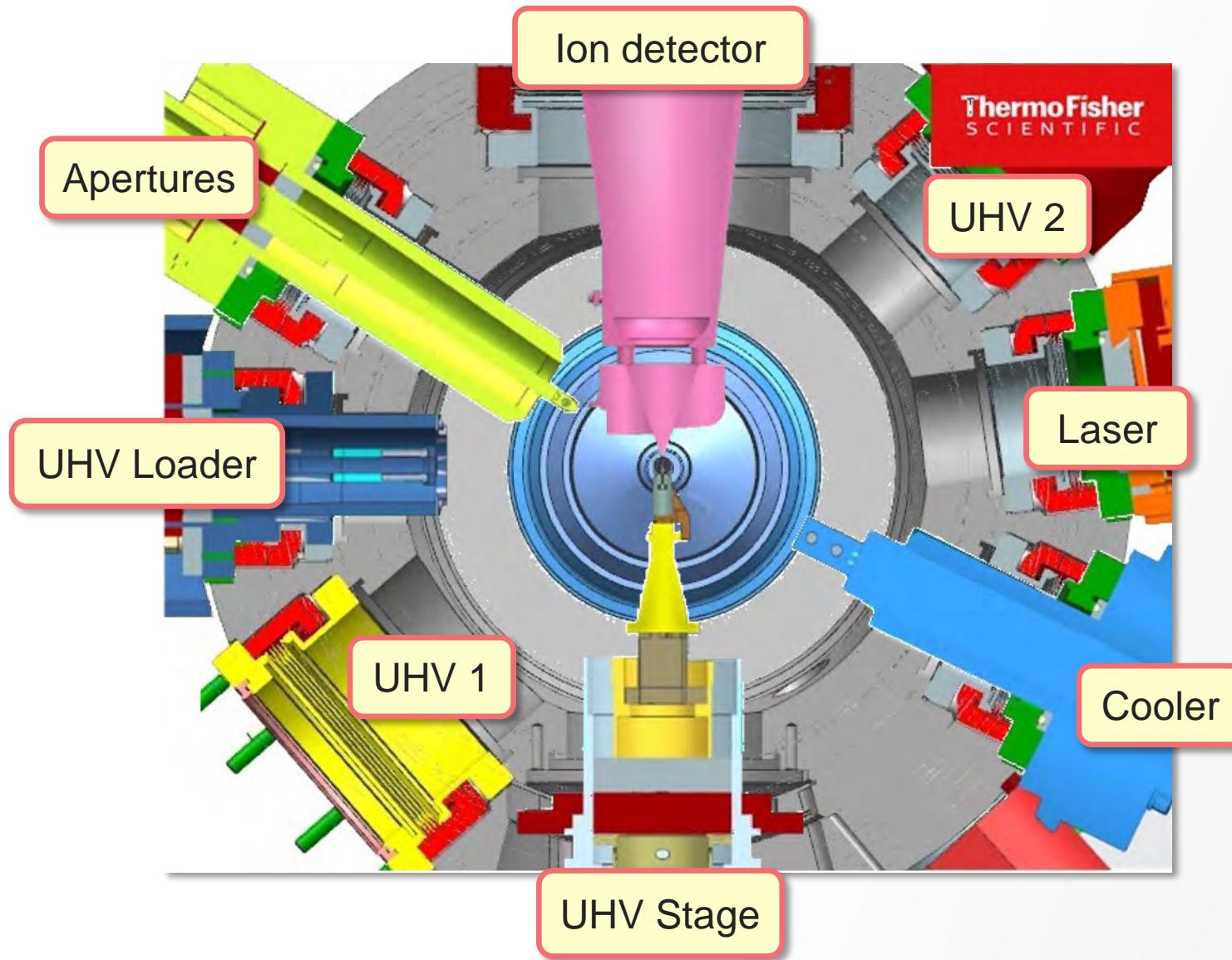


The Octagon

The Heart of the system

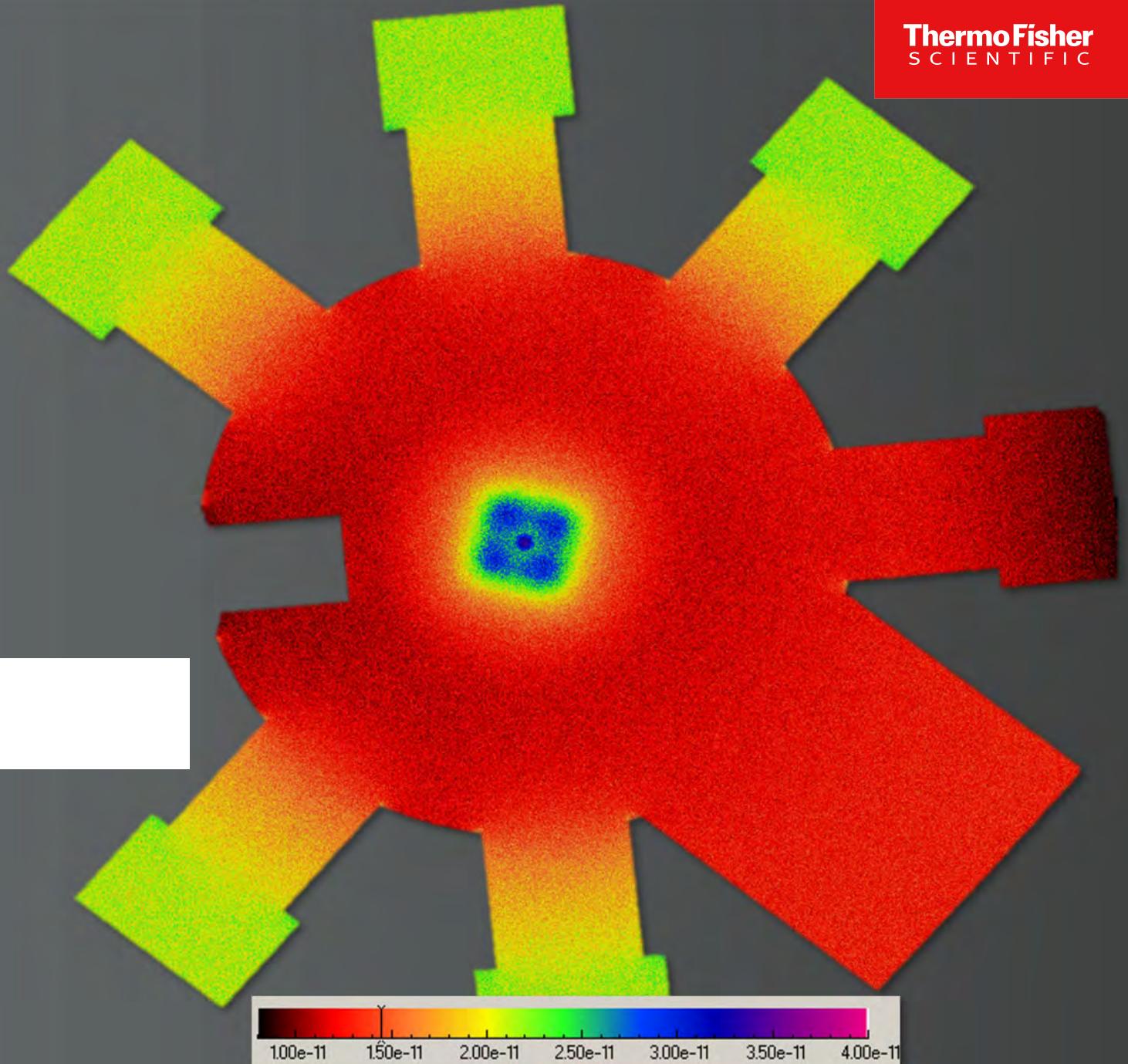
The Octagon

Sample area



- Laser
- Ion Detector
- Specimen chamber
 - Ultra High Vacuum
 - Optics
- Stage
- Loader
- Cooler
- ... and many more:
 - Elongated correctors
 - Holography
 - Tomography
 - 4x electrical contacts
 - EELS
 - Scripting access
- Coincidence

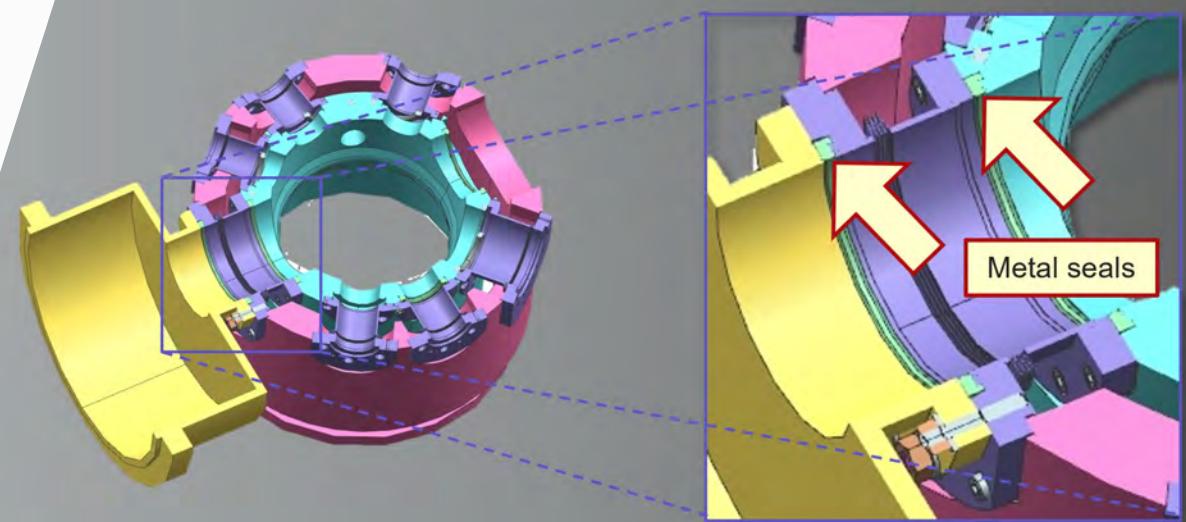
Ultra High Vacuum



Ultra High Vacuum

Achieving UHV

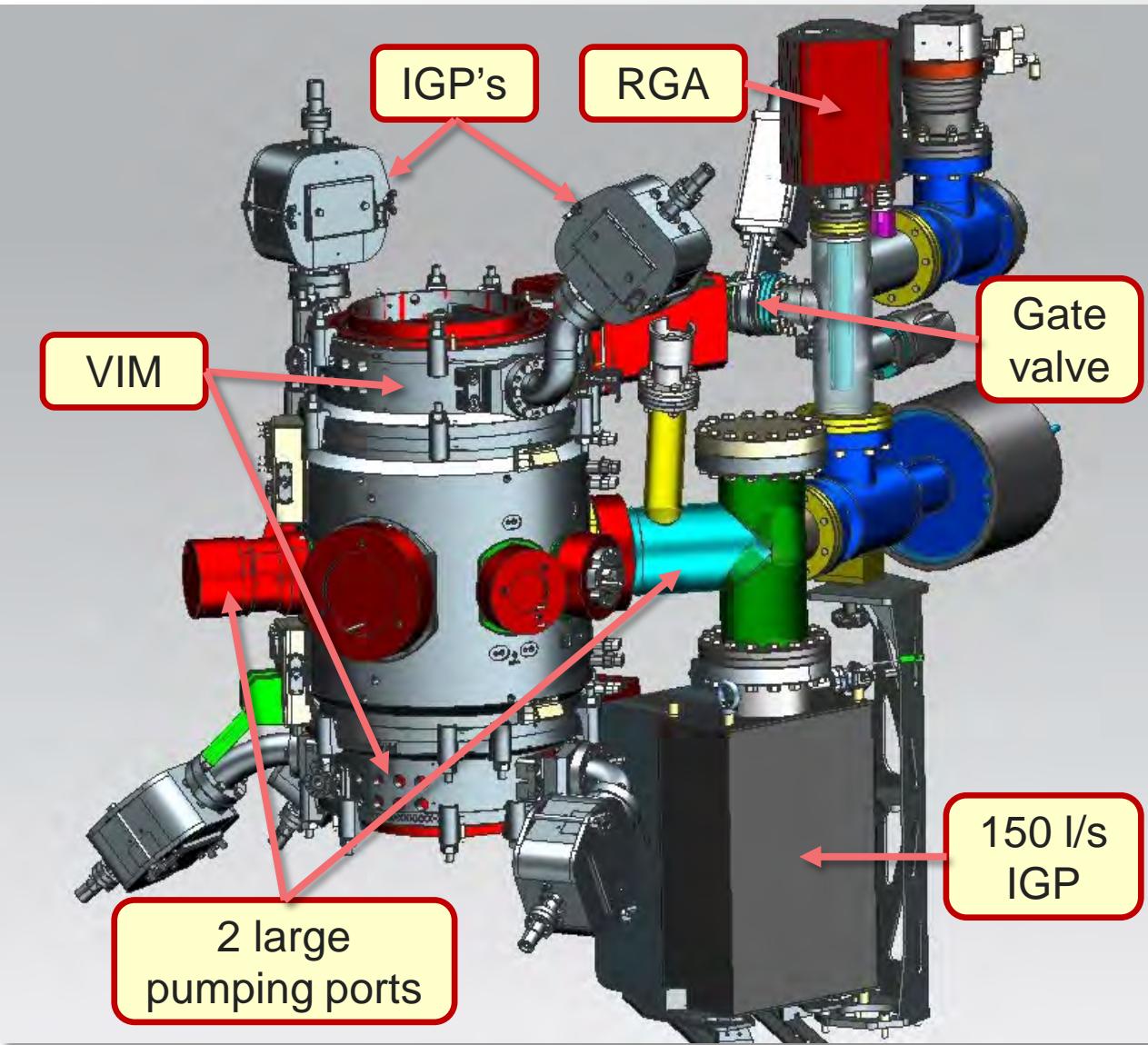
- Large pumps and pumping ports
- Differential pumping
- Bakeable
- Metal seals
- Rest Gas Analyzer for diagnostics
- UHV sample loader
- UHV compatible stage



Ultra High Vacuum

Achieving UHV

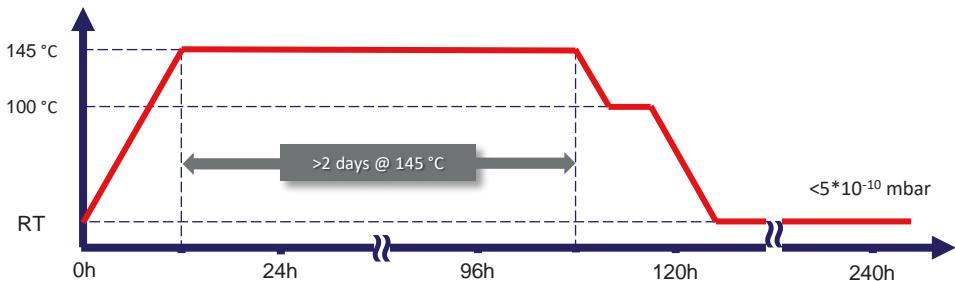
- Metal seals in all ports
- Heaters are build-in the Octagon:
 - Liner tube + stage + loader
- Active cooling for:
 - Lens coils
 - Stage drive train components
- Differential vacuum
 - Pressure limiting apertures in liner tube
 - Differential pumping by separate IGP's
- Vacuum Interface Modules (VIM)
 - Gate valves to preserve UHV (e.g., during service)



Ultra High Vacuum

Bakeable at 145 °C

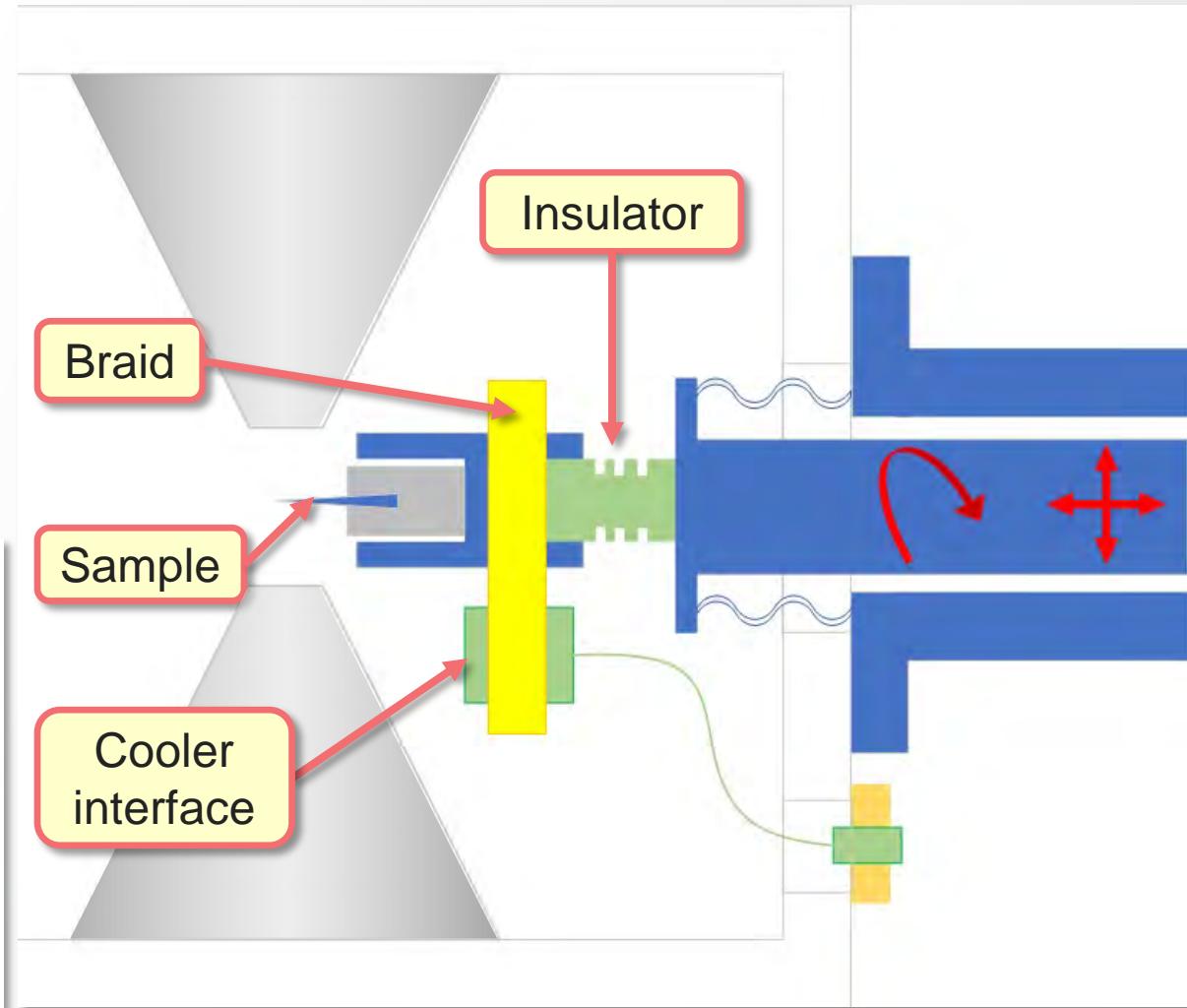
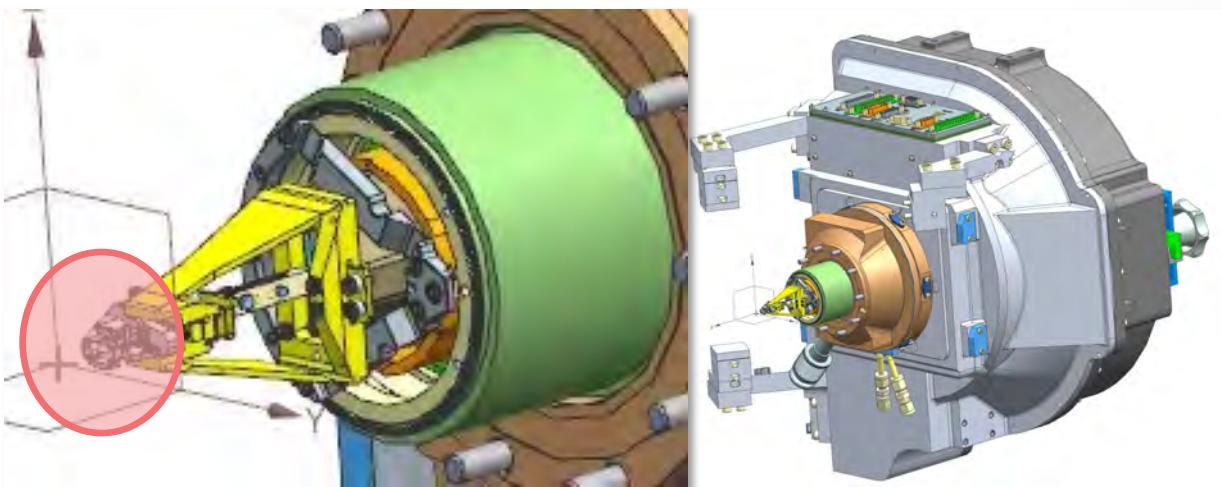
- Specimen chamber and Loader enclosed by tent
- Duration: ~ 1 week



Ultra High Vacuum

UHV compatible stage

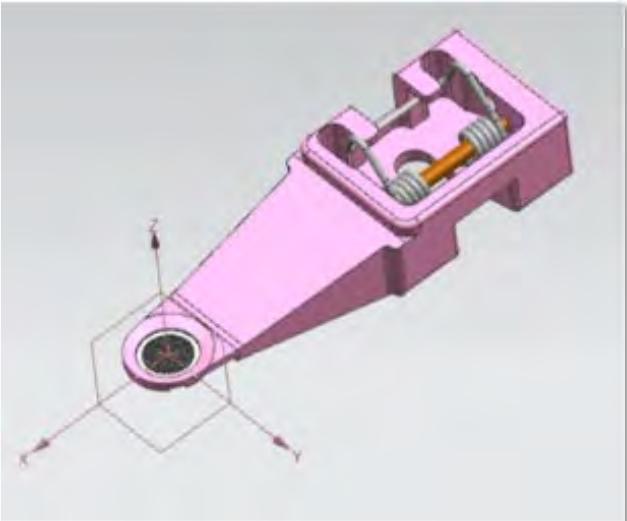
- UHV compatibility aspects:
 - Minimum moving components in vacuum
 - Cartridge loading from UHV Storage Chamber
 - Integrated heaters for bakeout
- -90° to $+90^\circ$ alpha tilt: full range tomography
- Compliant coupling towards Cryo cooler



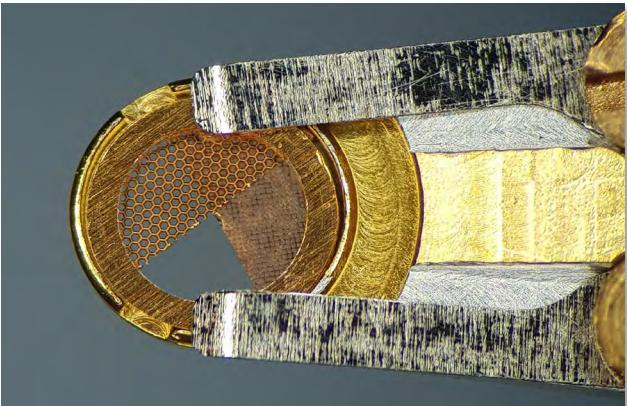
Ultra High Vacuum

Cartridge variants for different sample types

3mm grid cartridge



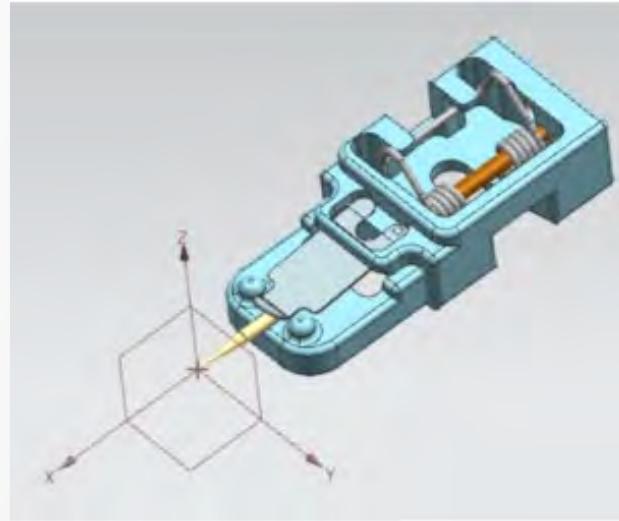
$\pm 90^\circ$ Alpha tilt



$\pm 6^\circ$ Beta tilt

(exceptionally up to $\pm 10^\circ$)

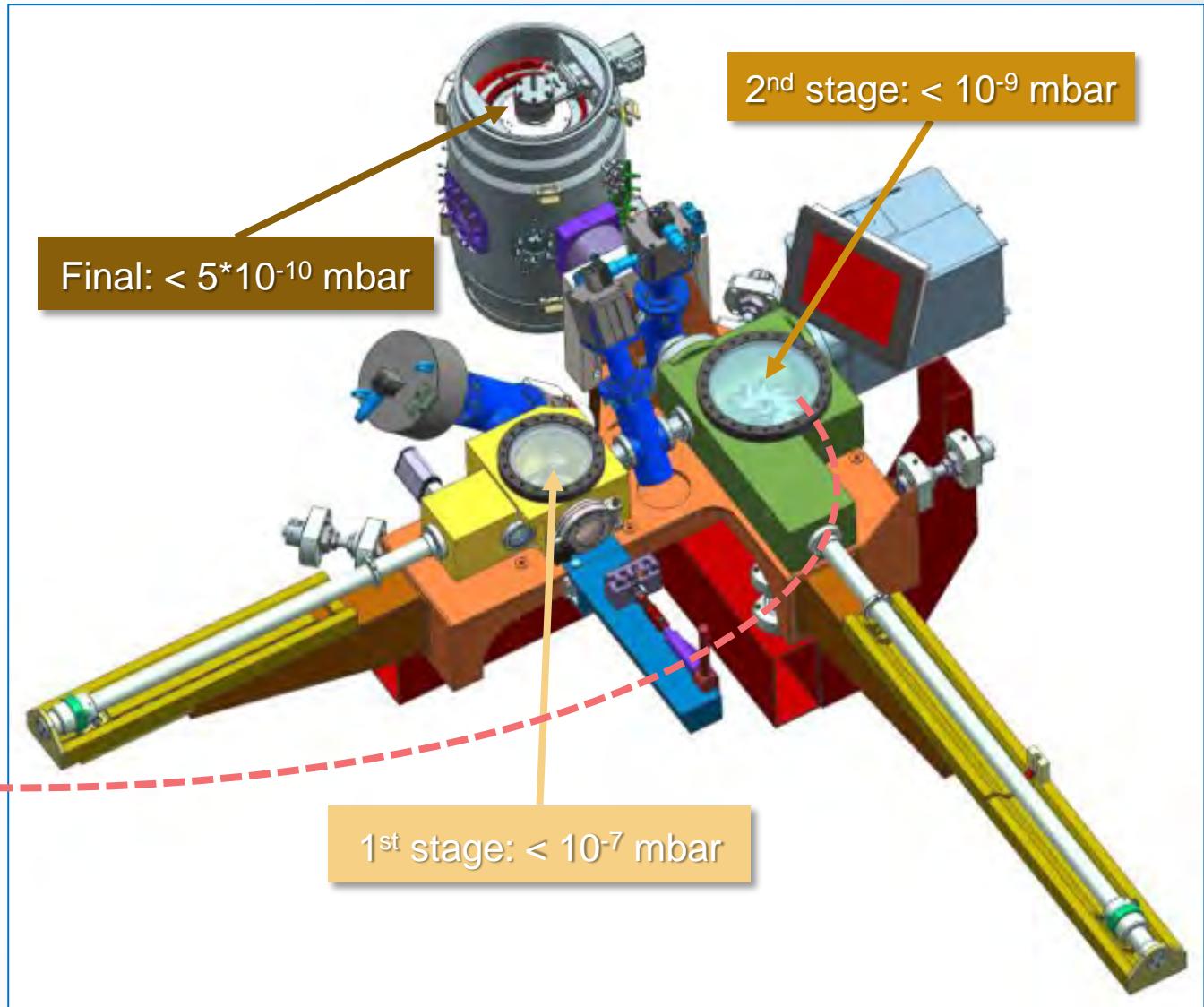
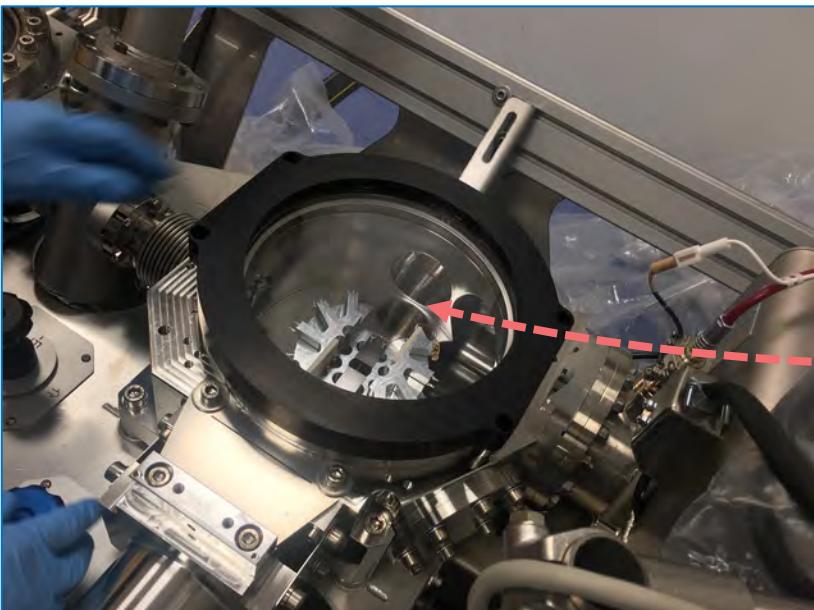
APT cartridge



Ultra High Vacuum

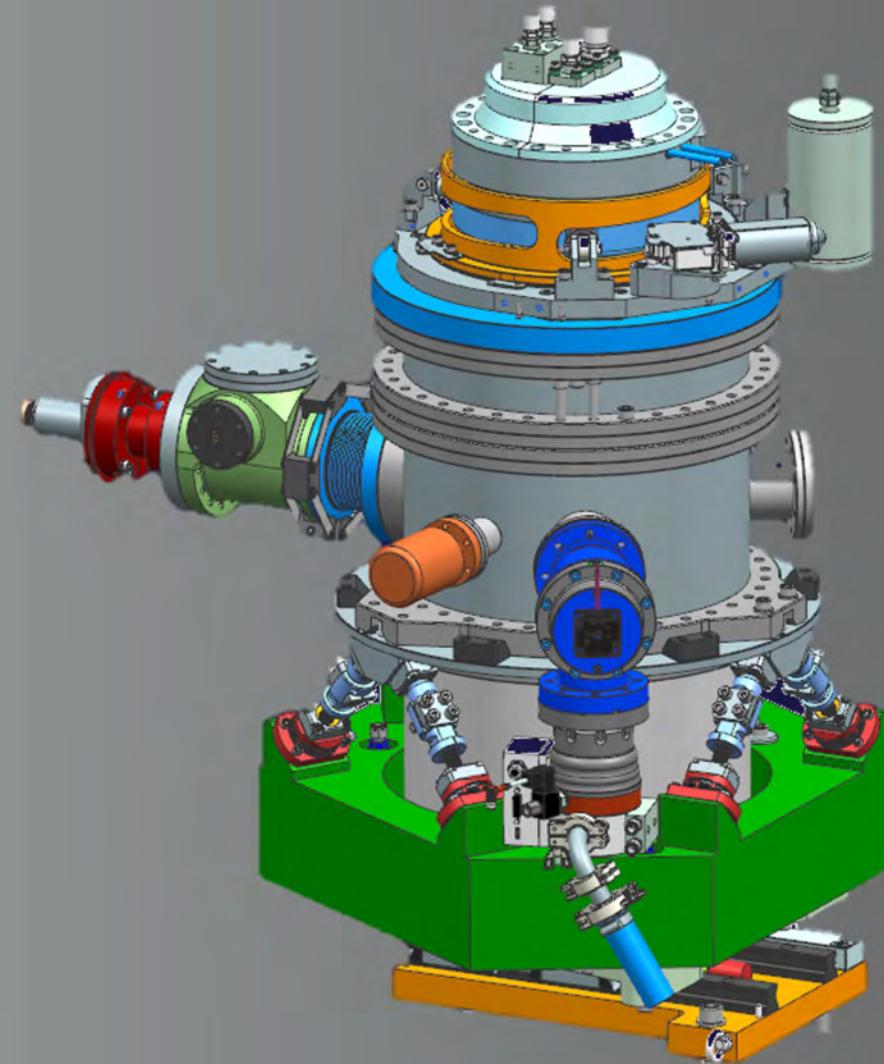
Sample loading

- Two-stage sample loading process
 - Load lock
 - Storage chamber
 - ~ 30 min pumping per stage
- Storage chamber prepared for direct UHV connection



Vibration-free cryo cooling

The battery cooler

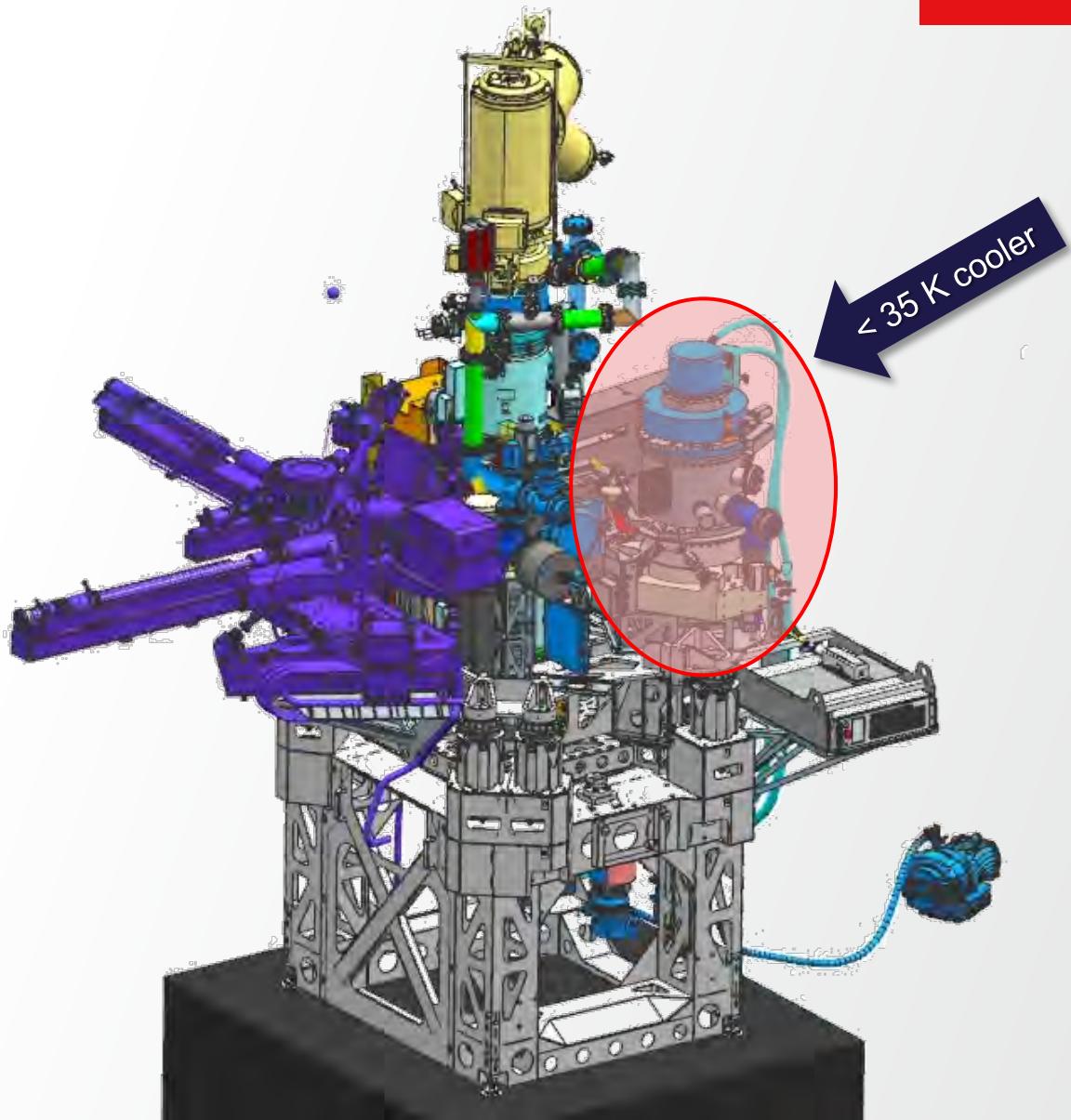
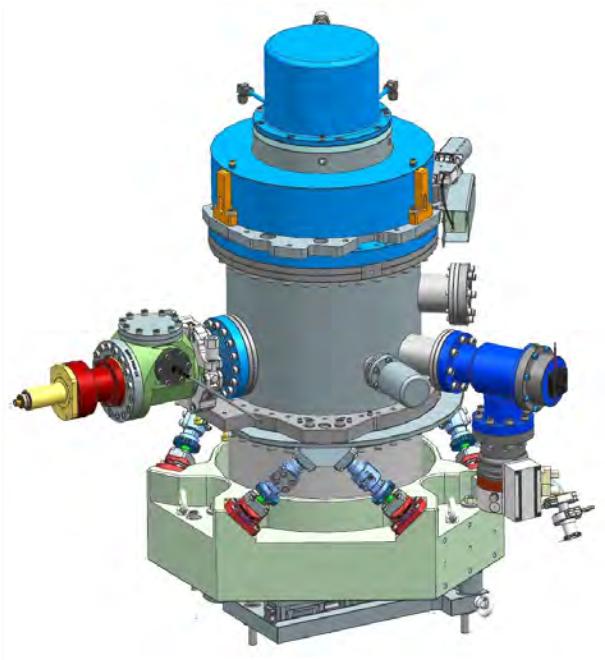


The battery cooler

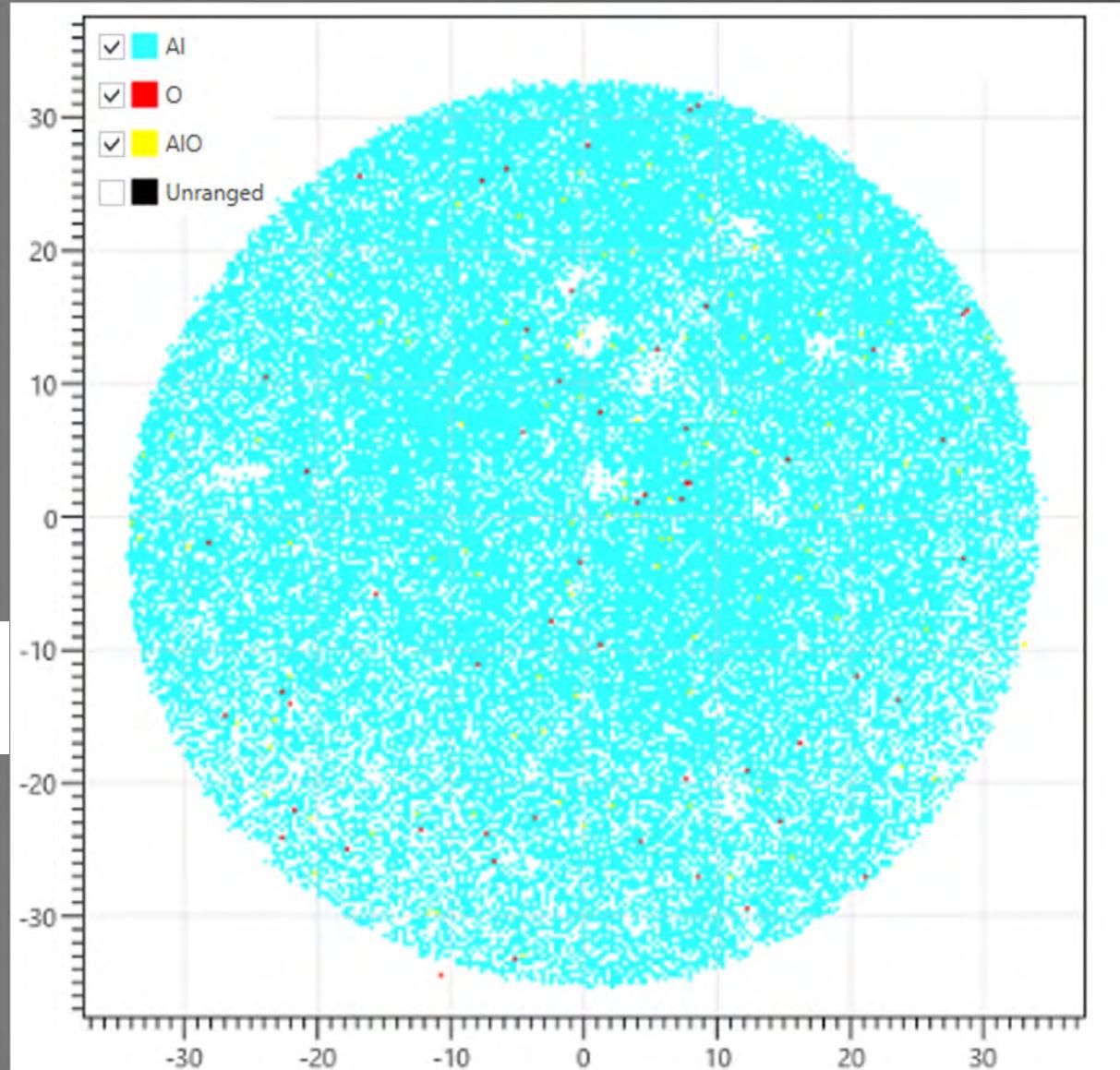
Vibration-free adjustable cooling

Cooler module

- $< 35 \text{ K} - 100 \text{ K}$
- Vibration free

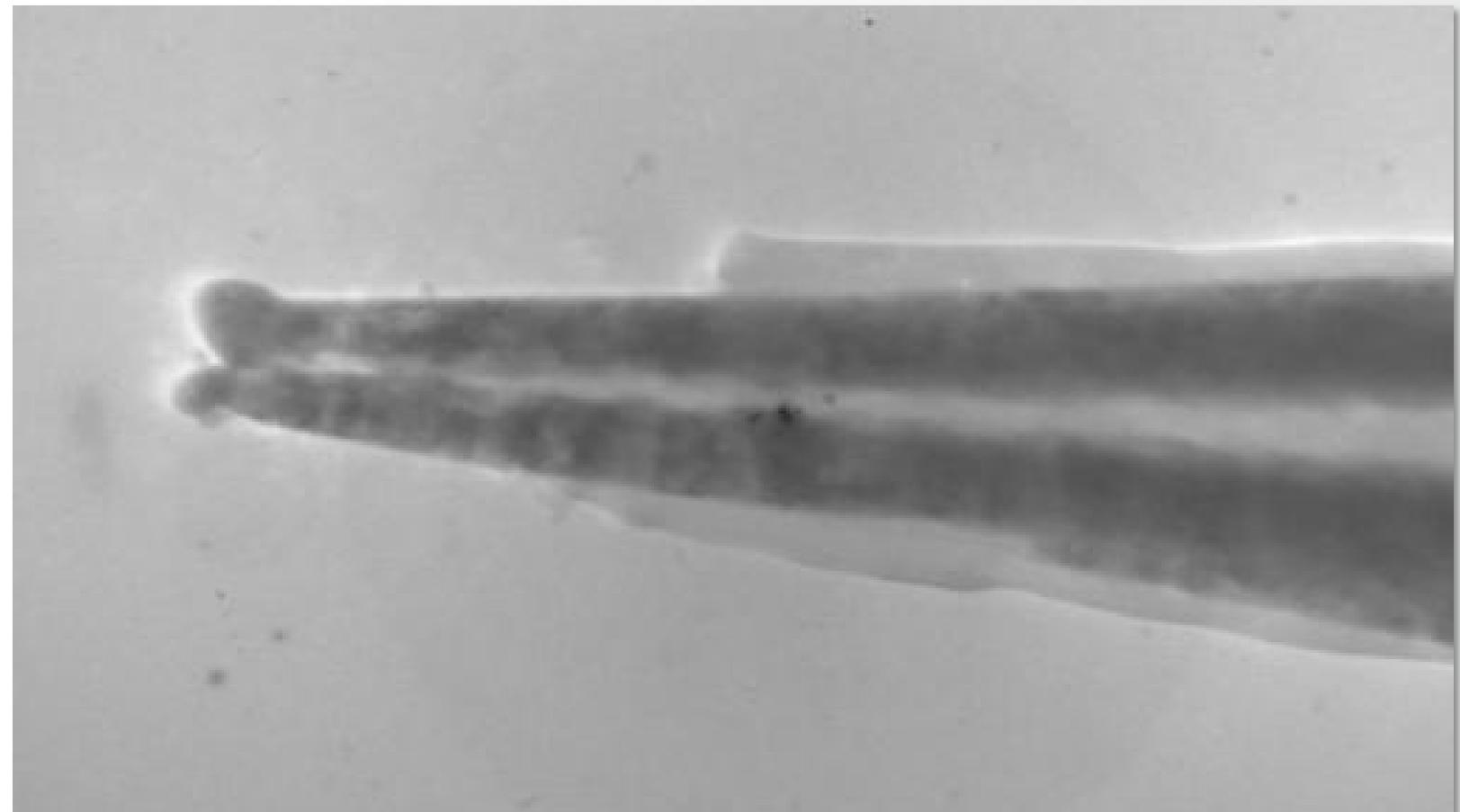


First experimental results



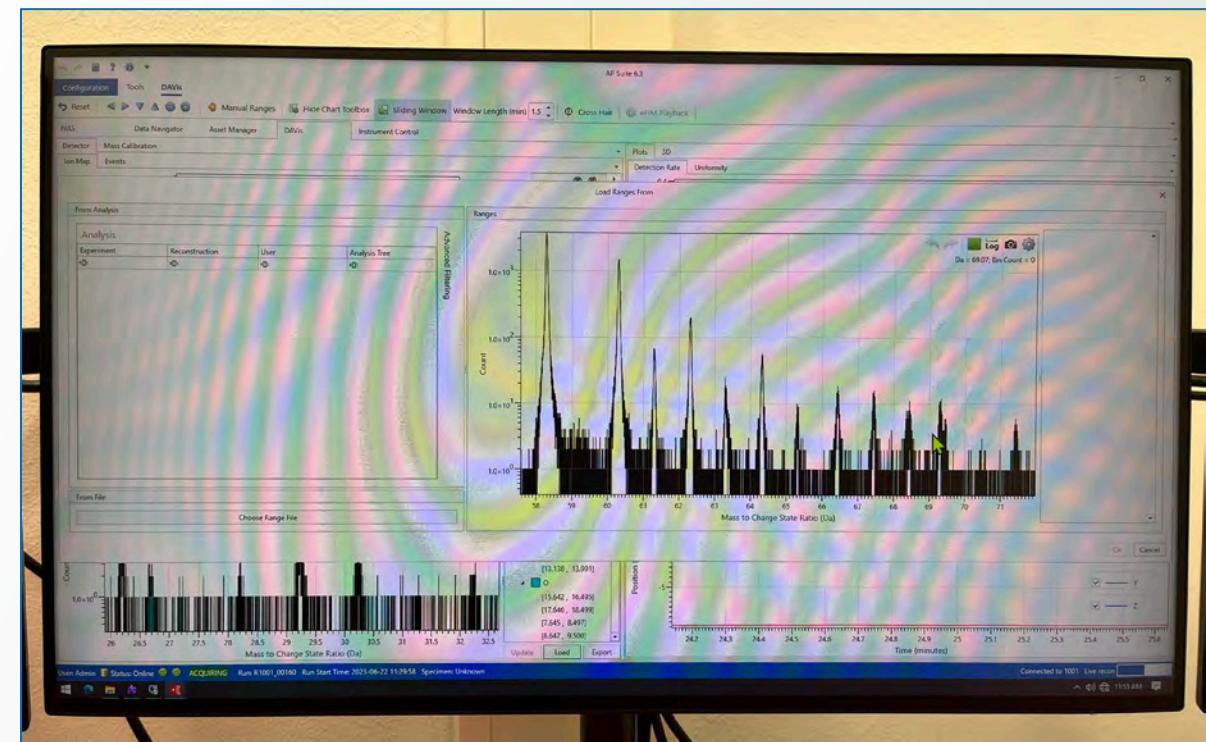
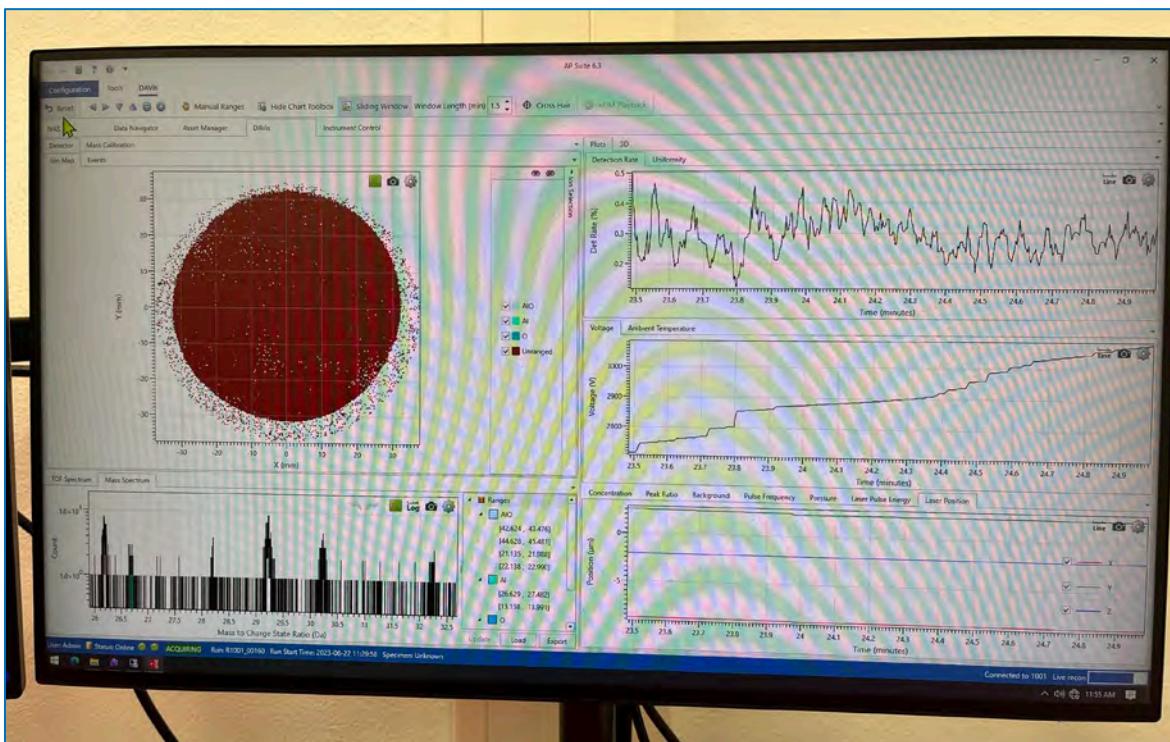
Sample and data provided by Cameca

- Standard Reference Material from NIST: SRM 2135c
- Consisting of Ni- and Cr-multilayers
 - Cr evaporates at 27 V/nm
 - Ni evaporates at 35 V/nm



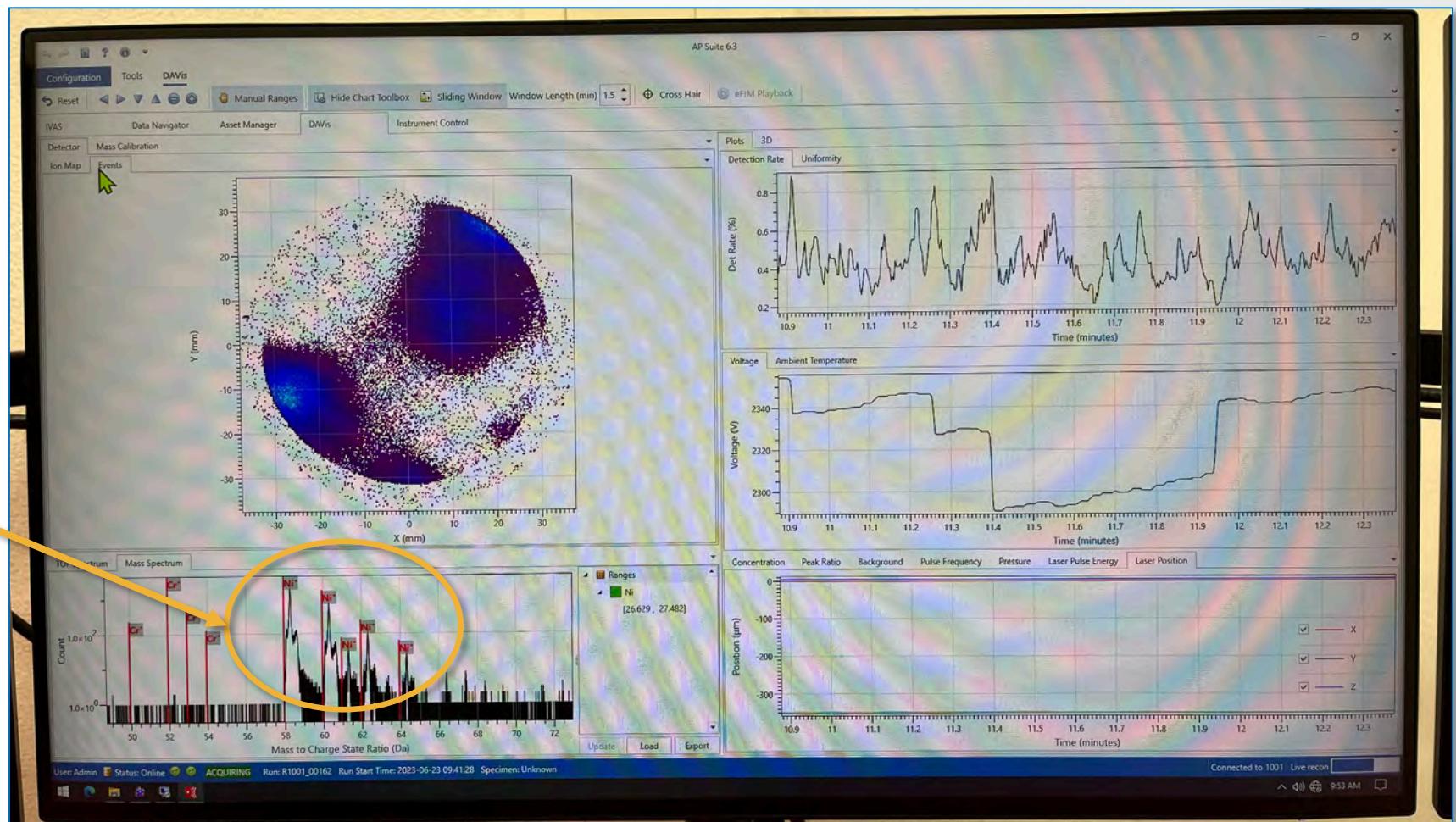
APT data acquisition

- Reasonable acquisition for about 26 min
- Expected elements were manually entered
 - Auto-calibration attempts were unsuccessful, elements shown are from a previous data run
- Spectral data looks good



APT data acquisition

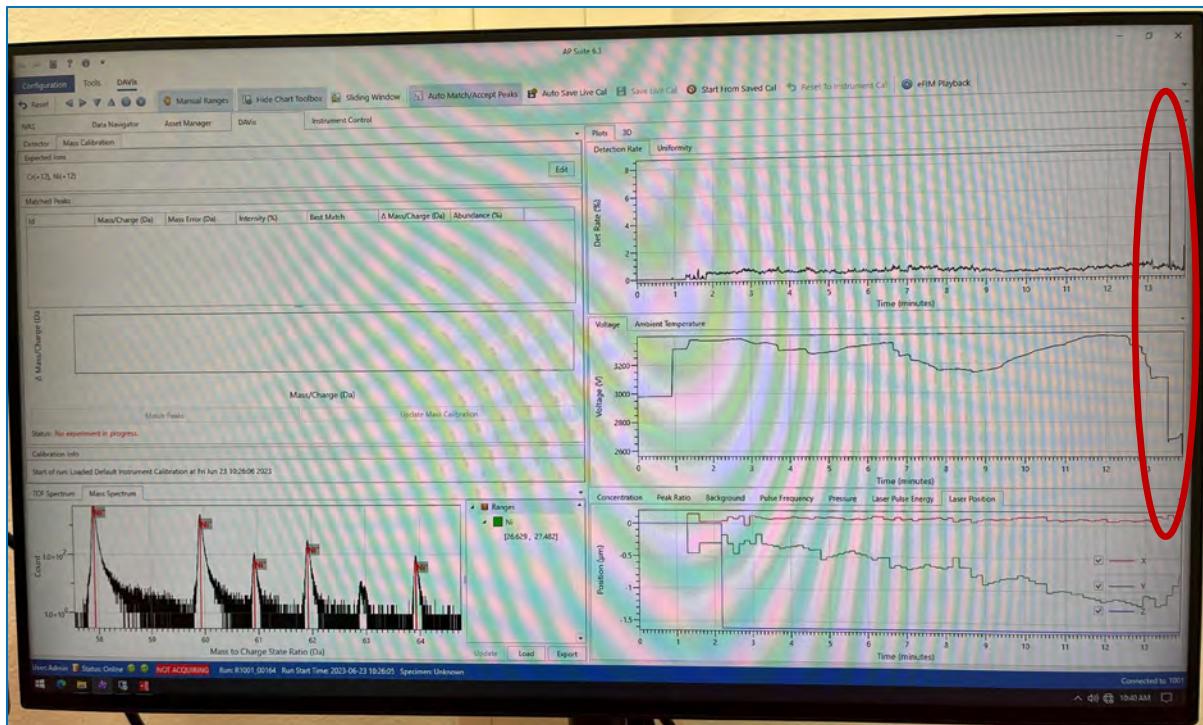
- Run 2 adds 600,000 ions to the 400,000 ions of run 1 for a total of **1 million ions**



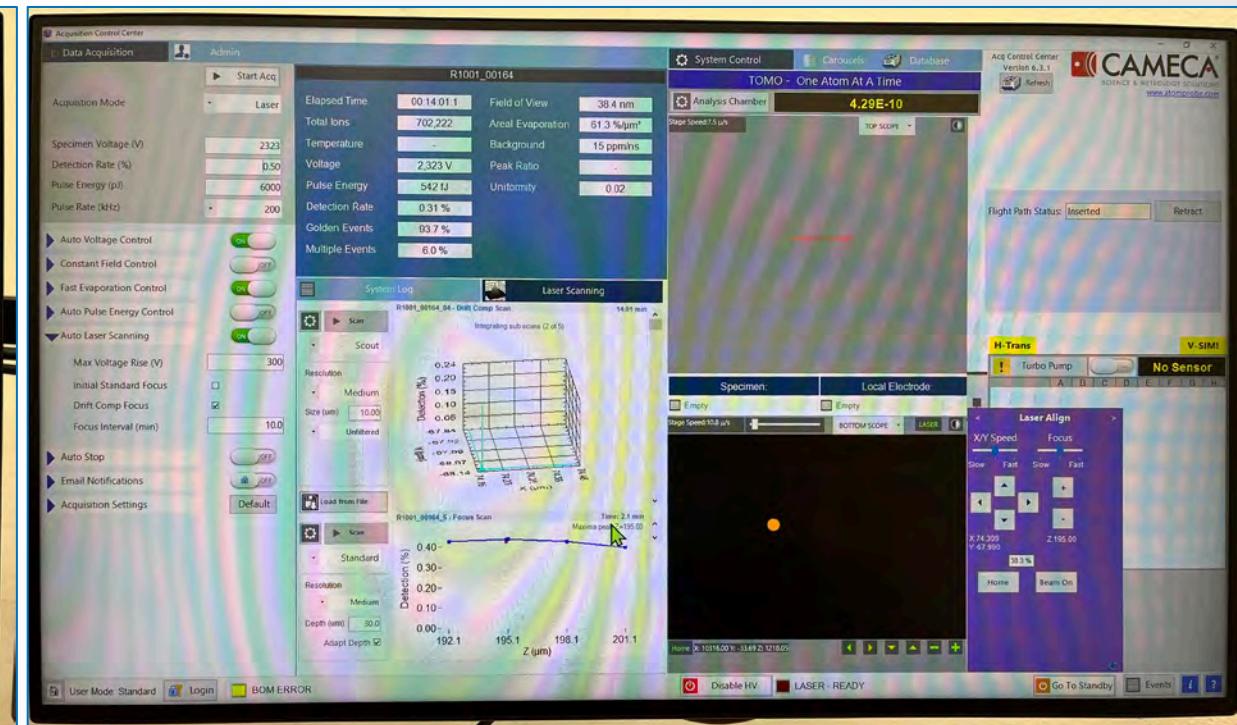
NiCr1-Exp2-IMG7887

APT data acquisition

- Run 4 adds 700,000 ions for a total of **2.7 million ions**
- Fracture event happens 13.5 minutes into run 4



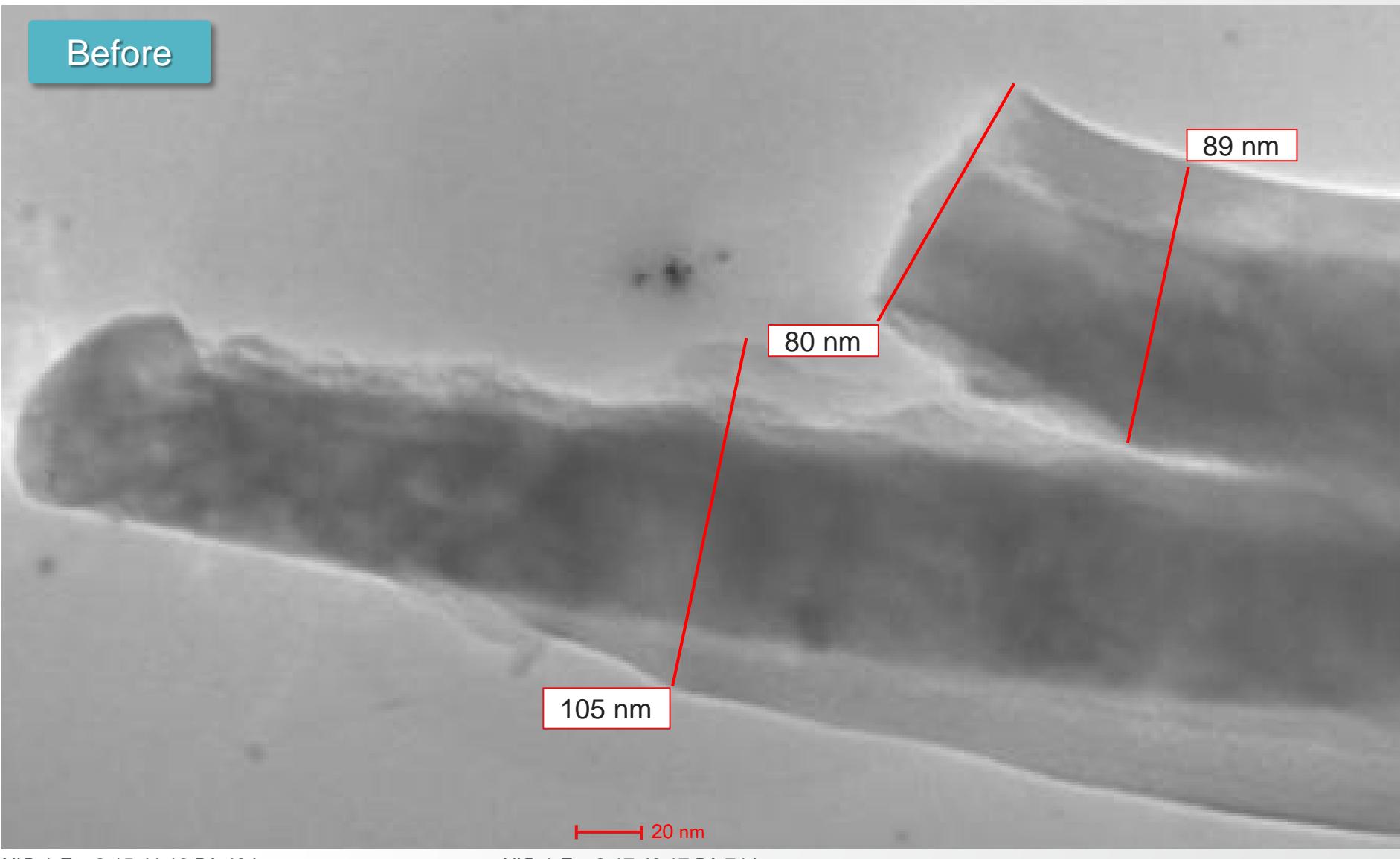
NiCr1-Exp2-IMG7897



NiCr1-Exp2-IMG7896

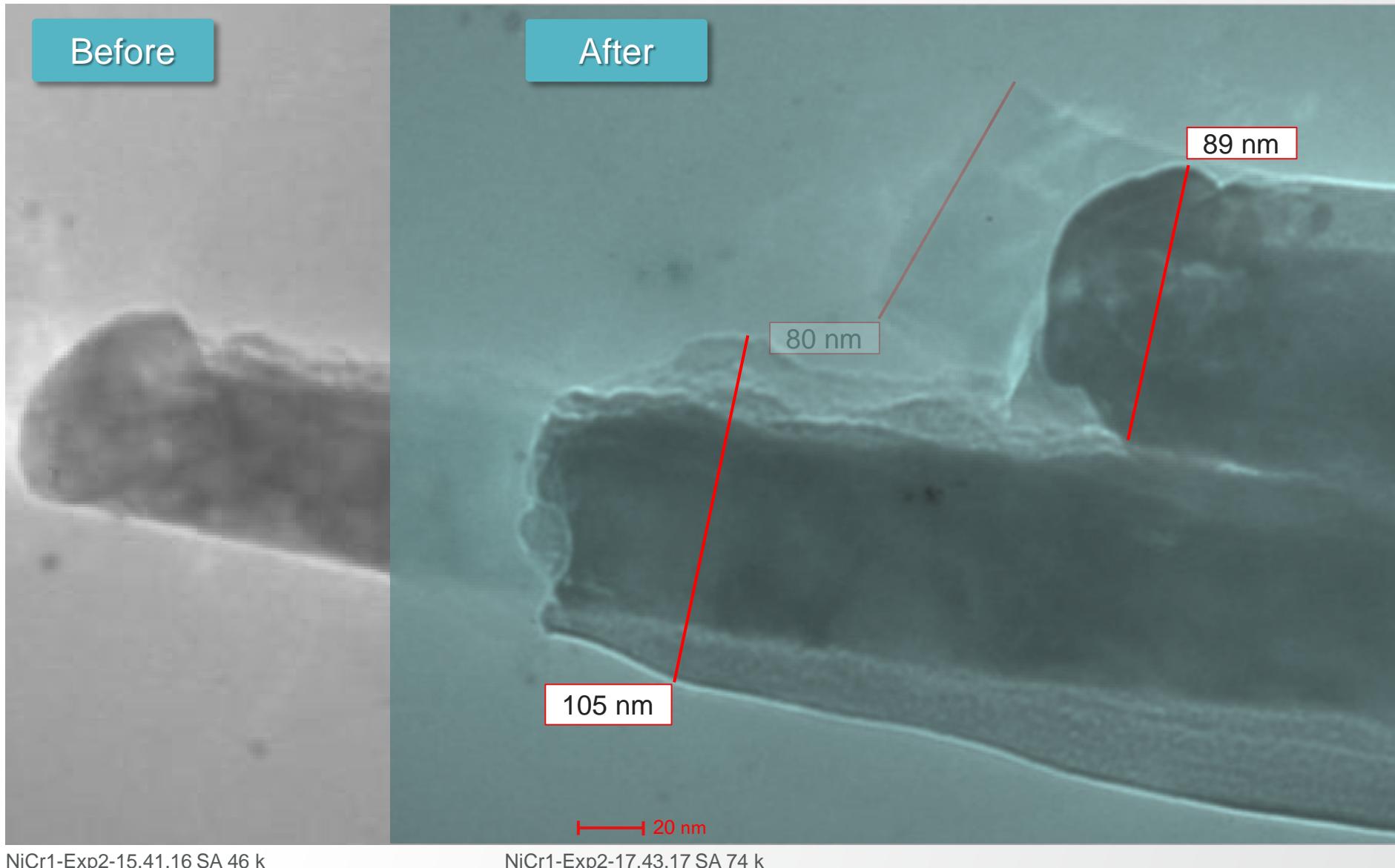
TEM imaging **before** and **after** run 4:

- Run 4: **2.7M ions**
- Fracture event at 13.5 min into run 4



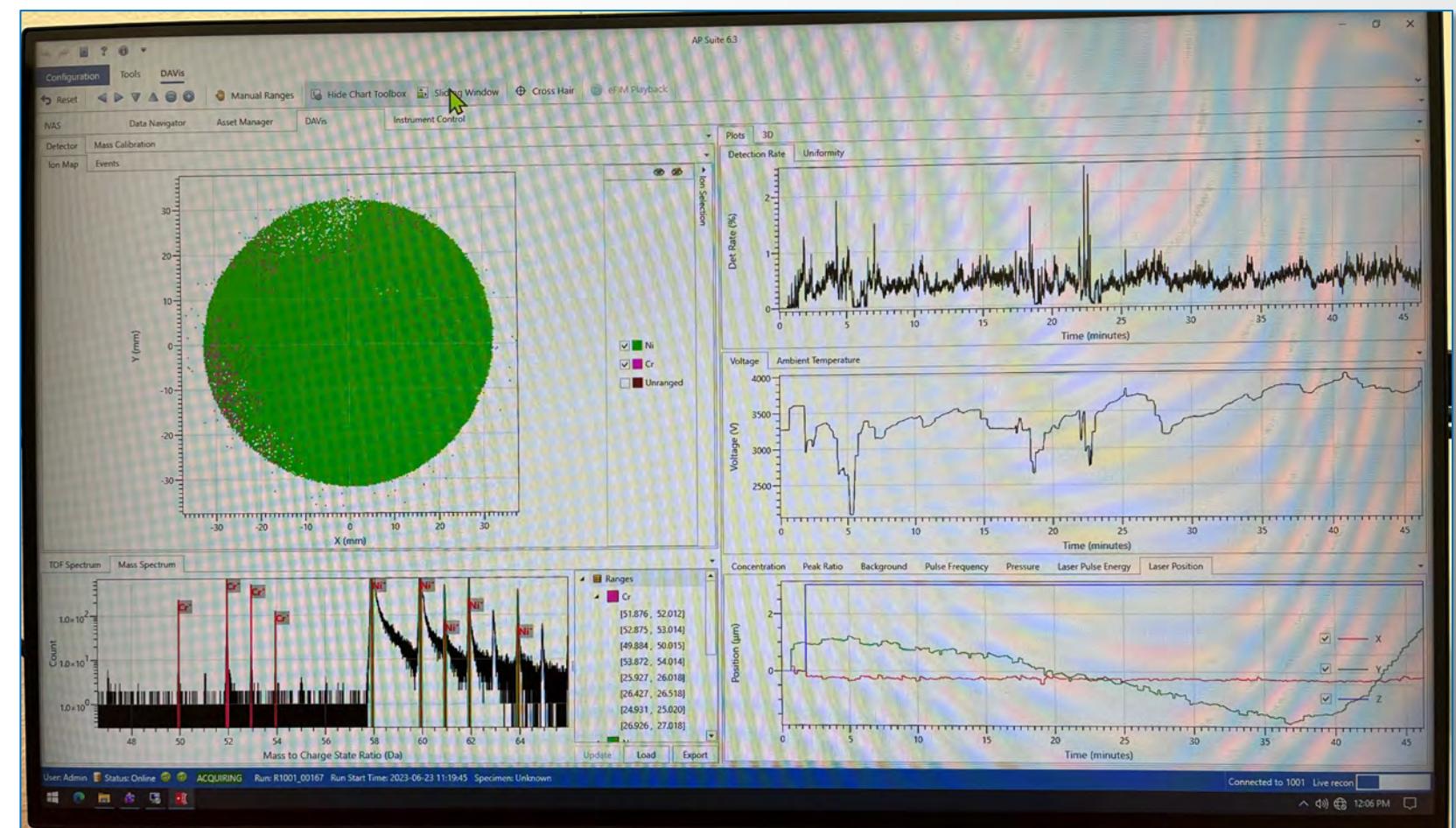
TEM imaging **before** and **after** run 4:

- Run 4: **2.7M ions**
- Fracture event at 13.5 min into run 4



APT data acquisition

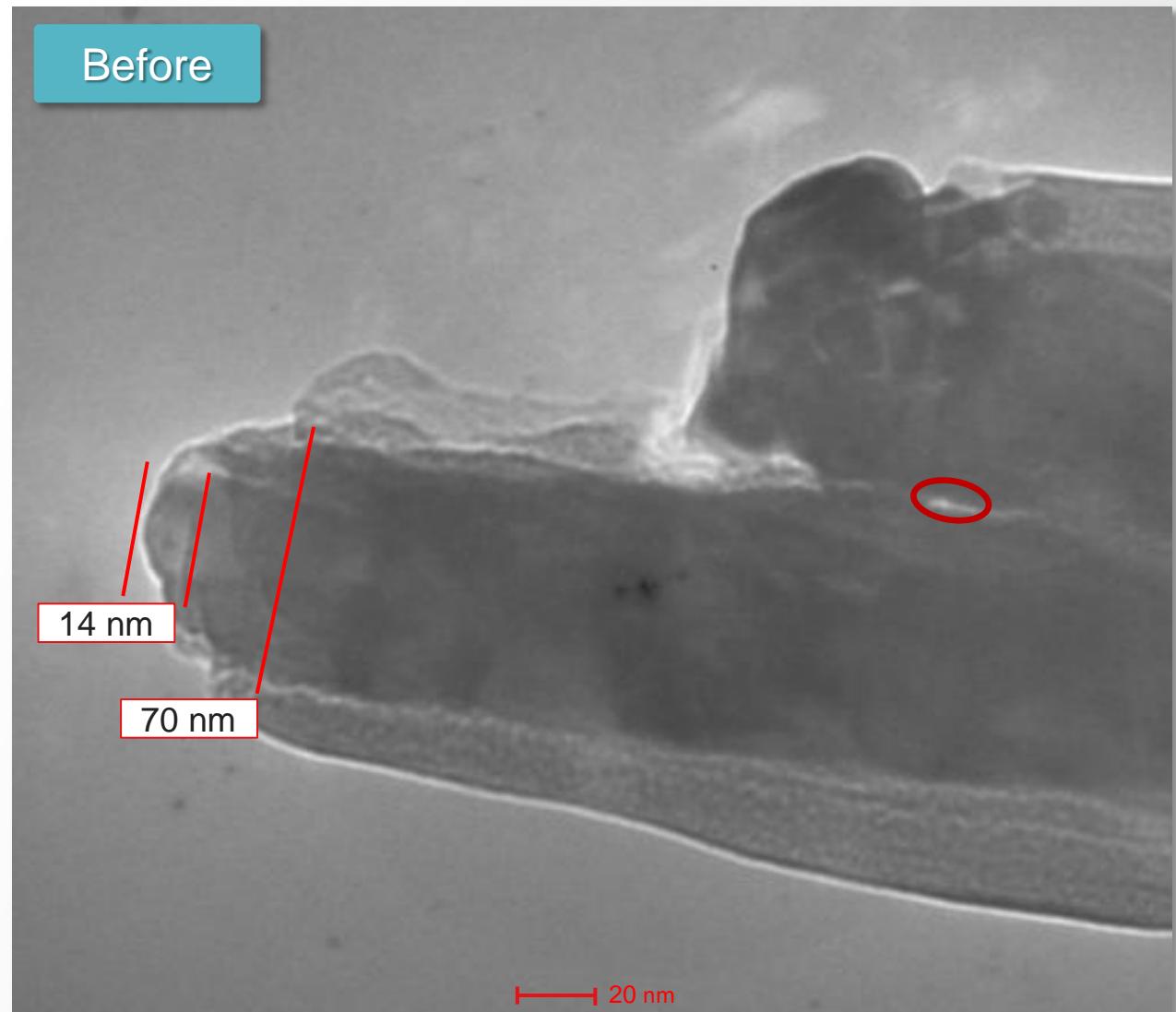
- Run 7 adds another 2,300,000 ions for a total of **6.2 M ions**
- Full run: 46:32 min
- Near instantaneous lock of laser positioning



NiCr1-Exp2-IMG_7906

TEM imaging **before** and **after** run 7:

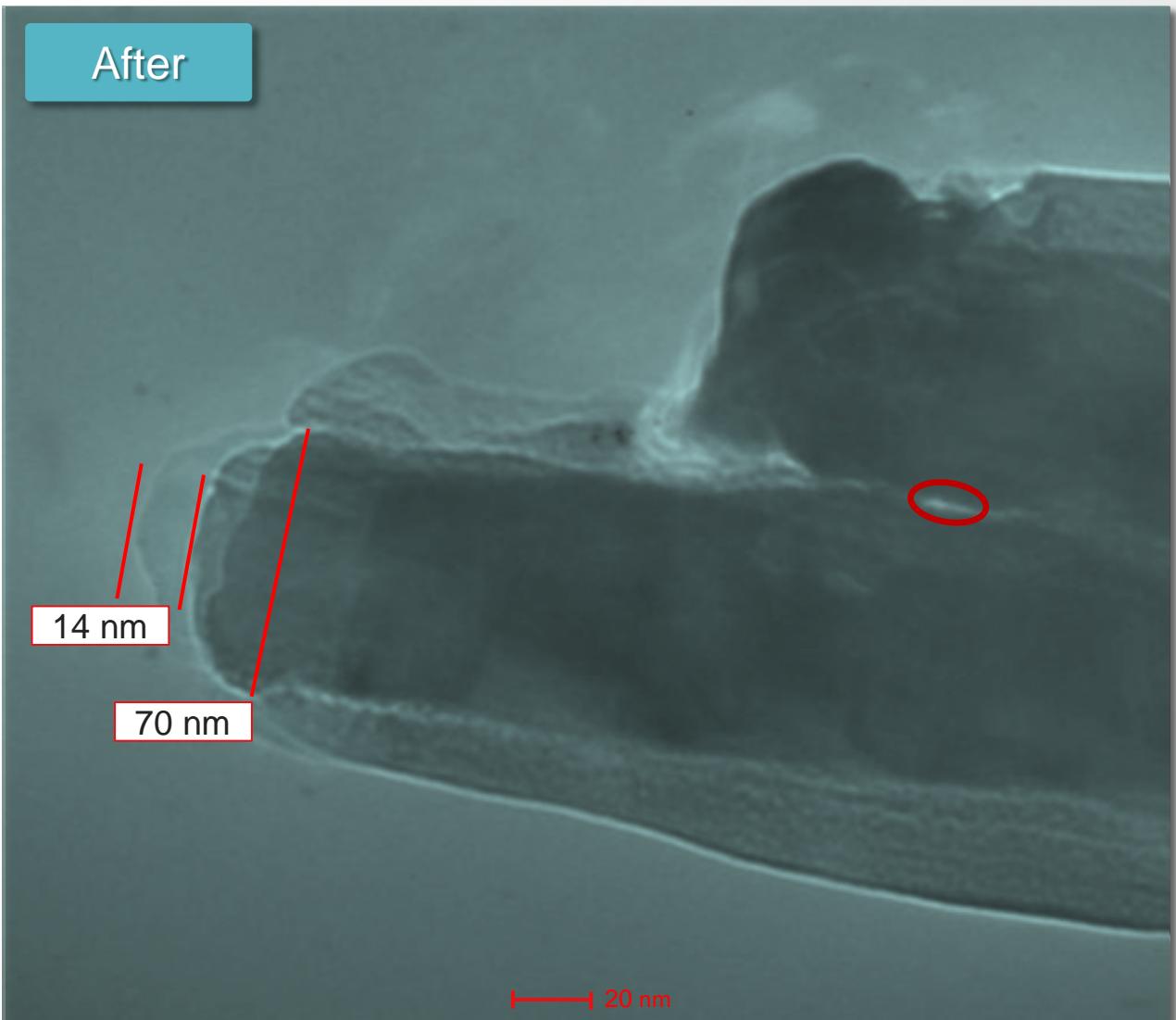
- Run 7 adds another 2,300,000 ions for a total of **6.2 M ions**
- Full run: 46:32 min
- Needle recedes 14 nm



TEM imaging **before** and **after** run 7:

- Run 7 adds another 2,300,000 ions for a total of **6.2 M ions**
- Full run: 46:32 min
- Needle recedes 14 nm

NiCr1-Exp2-18.20.22 SA 74 k
NiCr1-Exp2-19.09.40 SA 74 k



Closing remarks



Dedicated UHV vibration-free cryogenic (S)TEM + APT



Semiconductors:
3D-visualization of dopants



Energy materials:
Reactive elements in a pristine state, chemical reactions in controlled conditions



Quantum materials:
Experimental stimuli at stable conditions and adjustable, low temperatures



Surface analysis:
Chemistry in ultra-clean conditions, long experimentation windows

Thank you

